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Declarations under Rule 4.17:

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(54) Title: DARKFIELD TRACKING

(57) Abstract: In a method for darkfield tracking at a sensor, it is determined whether an object is interacting with the sensor. Provided an object is not interacting with the sensor, a determination that a darkfield candidate image can be captured at the sensor is made. It is determined whether to capture a darkfield candidate image at the sensor based at least in part on the determination that a darkfield candidate image can be captured at the sensor. Responsive to making a determination to capture the darkfield candidate image, the darkfield candidate image is captured at the sensor, wherein the darkfield candidate image is an image absent an object interacting with the sensor. A darkfield estimate is updated with the darkfield candidate image.



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DARKFIELD TRACKING

RELATED APPLICATIONS

[0001] This application claims priority to and the benefit of co-pending U.S. Provisional Patent Application 62/593,848, filed on December 1, 2017, entitled "DARKFIELD TRACKER," by Abbas Ataya, having Attorney Docket No. IVS-778-PR, and assigned to the assignee of the present application, which is incorporated herein by reference in its entirety.

[0002] This application claims priority to and the benefit of co-pending U.S. Patent Application 16/206,527, filed on November 30, 2018, entitled "DARKFIELD TRACKING", by Ataya et al., having Attorney Docket No. IVS-860, and assigned to the assignee of the present application, which is incorporated herein by reference in its entirety.

BACKGROUND

[0003] Fingerprint sensors have become ubiquitous in mobile devices as well as other applications for authenticating a user's identity. They provide a fast and convenient way for the user to unlock a device, provide authentication for payments, etc. Current fingerprint sensors are typically area sensors that obtain a two-dimensional image of the user's finger area presented to the sensor. Different technologies can be used to image the finger such as capacitive, ultrasound, and optical sensing. Once an image is obtained, that image is processed by a matcher to extract features and to compare against stored images to authenticate the user. As such, accuracy of captured images is essential to the performance of image matching for user authentication.

BRIEF DESCRIPTION OF THE DRAWINGS

[0003] The accompanying drawings, which are incorporated in and form a part of the Description of Embodiments, illustrate various embodiments of the subject matter and, together with the Description of Embodiments, serve to explain principles of the subject matter discussed below. Unless specifically noted, the drawings referred to in this Brief Description of Drawings should be understood as not being drawn to scale. Herein, like items are labeled with like item numbers.

[0004] FIG. 1A is a diagram illustrating a piezoelectric micromachined ultrasonic transducer (PMUT) device having a center pinned membrane, according to some embodiments.

[0005] FIG. 1B is a diagram illustrating a PMUT device having an unpinned membrane, according to some embodiments.

[0006] FIG. 2 is a diagram illustrating an example of membrane movement during activation of a PMUT device having a center pinned membrane, according to some embodiments.

[0007] FIG. 3 is a top view of the PMUT device of FIG. 1A, according to some embodiments.

[0008] FIG. 4 is a simulated map illustrating maximum vertical displacement of the membrane of the PMUT device shown in FIGs. 1A, 2, and 3, according to some embodiments.

[0009] FIG. 5 is a top view of an example PMUT device having a circular shape, according to some embodiments.

[0010] FIG. 6 illustrates an example array of square-shaped PMUT devices, according to some embodiments.

[0011] FIG. 7A illustrates an example of an operational environment for sensing of human touch, according to some embodiments.

[0012] FIG. 7B illustrates an example fingerprint sensor, in accordance with various embodiments.

[0013] FIG. 8 illustrates a flow diagram of an example method for capturing a darkfield image, according to some embodiments

[0014] FIG. 9 illustrates example operation of void detection associated with a two-dimensional array of ultrasonic transducers, according to some embodiments.

[0015] FIGs. 10A-10E illustrate graphs of pixel values relative to time during void detection at a sensor, according to an embodiment.

[0016] FIG. 11 illustrates a flow diagram of a method for void detection, according to various embodiments.

[0017] FIG. 12 illustrates a flow diagram of a method for darkfield tracking, according to various embodiments.

[0018] FIG. 13 illustrates a flow diagram an example method for determining whether an object is interacting with the sensor.

[0019] FIG. 14 illustrates a flow diagram another example method for determining whether an object is interacting with the sensor

DESCRIPTION OF EMBODIMENTS

[0020] The following Description of Embodiments is merely provided by way of example and not of limitation. Furthermore, there is no intention to be bound by any expressed or implied theory presented in the preceding background or in the following Description of Embodiments.

[0021] Reference will now be made in detail to various embodiments of the subject matter, examples of which are illustrated in the accompanying drawings. While various embodiments are discussed herein, it will be understood that they are not intended to limit to these embodiments. On the contrary, the presented embodiments are intended to cover alternatives, modifications and equivalents, which may be included within the spirit and scope the various embodiments as defined by the appended claims. Furthermore, in this Description of Embodiments, numerous specific details are set forth in order to provide a thorough understanding of embodiments of the present subject matter. However, embodiments may be practiced without these specific details. In other instances, well known methods, procedures, components, and circuits have not been described in detail as not to unnecessarily obscure aspects of the described embodiments.

Notation and Nomenclature

[0022] Some portions of the detailed descriptions which follow are presented in terms of procedures, logic blocks, processing and other symbolic representations of operations on data within an electrical device. These descriptions and representations are the means used by those skilled in the data processing arts to most effectively convey the substance of their work to others skilled in the art. In the present application, a procedure, logic block, process, or the like, is conceived to be one or more self-consistent procedures or instructions leading to a desired result. The procedures are those requiring physical manipulations of physical quantities. Usually, although not necessarily, these quantities take the form of acoustic (e.g., ultrasonic) signals capable of being transmitted and received by an electronic device and/or electrical or magnetic signals capable of being stored, transferred, combined, compared, and otherwise manipulated in an electrical device.

[0023] It should be borne in mind, however, that all of these and similar terms are to be associated with the appropriate physical quantities and are merely convenient labels applied to these quantities. Unless specifically stated otherwise as apparent from the following discussions, it is appreciated that throughout the description of embodiments, discussions utilizing terms such as “determining,” “making,” “capturing,” “updating,” “generating,” “merging,”

"storing," "transmitting," "receiving," "comparing," "updating," "correcting," or the like, refer to the actions and processes of an electronic device such as an electrical device.

[0024] Embodiments described herein may be discussed in the general context of processor-executable instructions residing on some form of non-transitory processor-readable medium, such as program modules, executed by one or more computers or other devices. Generally, program modules include routines, programs, objects, components, data structures, etc., that perform particular tasks or implement particular abstract data types. The functionality of the program modules may be combined or distributed as desired in various embodiments.

[0025] In the figures, a single block may be described as performing a function or functions; however, in actual practice, the function or functions performed by that block may be performed in a single component or across multiple components, and/or may be performed using hardware, using software, or using a combination of hardware and software. To clearly illustrate this interchangeability of hardware and software, various illustrative components, blocks, modules, logic, circuits, and steps have been described generally in terms of their functionality. Whether such functionality is implemented as hardware or software depends upon the particular application and design constraints imposed on the overall system. Skilled artisans may implement the described functionality in varying ways for each particular application, but such implementation decisions should not be interpreted as causing a departure from the scope of the present disclosure. Also, the example fingerprint sensing system and/or mobile electronic device described herein may include components other than those shown, including well-known components.

[0026] Various techniques described herein may be implemented in hardware, software, firmware, or any combination thereof, unless specifically described as being implemented in a specific manner. Any features described as modules or components may also be implemented together in an integrated logic device or separately as discrete but interoperable logic devices. If implemented in software, the techniques may be realized at least in part by a non-transitory processor-readable storage medium comprising instructions that, when executed, perform one or more of the methods described herein. The non-transitory processor-readable data storage medium may form part of a computer program product, which may include packaging materials.

[0027] The non-transitory processor-readable storage medium may comprise random access memory (RAM) such as synchronous dynamic random access memory (SDRAM), read only memory (ROM), non-volatile random access memory (NVRAM), electrically erasable programmable read-only memory (EEPROM), FLASH memory, other known storage media,

and the like. The techniques additionally, or alternatively, may be realized at least in part by a processor-readable communication medium that carries or communicates code in the form of instructions or data structures and that can be accessed, read, and/or executed by a computer or other processor.

[0028] Various embodiments described herein may be executed by one or more processors, such as one or more motion processing units (MPUs), sensor processing units (SPUs), host processor(s) or core(s) thereof, digital signal processors (DSPs), general purpose microprocessors, application specific integrated circuits (ASICs), application specific instruction set processors (ASIPs), field programmable gate arrays (FPGAs), a programmable logic controller (PLC), a complex programmable logic device (CPLD), a discrete gate or transistor logic, discrete hardware components, or any combination thereof designed to perform the functions described herein, or other equivalent integrated or discrete logic circuitry. The term "processor," as used herein may refer to any of the foregoing structures or any other structure suitable for implementation of the techniques described herein. As it employed in the subject specification, the term "processor" can refer to substantially any computing processing unit or device comprising, but not limited to comprising, single-core processors; single-processors with software multithread execution capability; multi-core processors; multi-core processors with software multithread execution capability; multi-core processors with hardware multithread technology; parallel platforms; and parallel platforms with distributed shared memory. Moreover, processors can exploit nano-scale architectures such as, but not limited to, molecular and quantum-dot based transistors, switches and gates, in order to optimize space usage or enhance performance of user equipment. A processor may also be implemented as a combination of computing processing units.

[0029] In addition, in some aspects, the functionality described herein may be provided within dedicated software modules or hardware modules configured as described herein. Also, the techniques could be fully implemented in one or more circuits or logic elements. A general purpose processor may be a microprocessor, but in the alternative, the processor may be any conventional processor, controller, microcontroller, or state machine. A processor may also be implemented as a combination of computing devices, e.g., a combination of an SPU/MPU and a microprocessor, a plurality of microprocessors, one or more microprocessors in conjunction with an SPU core, MPU core, or any other such configuration.

OVERVIEW OF DISCUSSION

[0030] Discussion begins with a description of an example piezoelectric micromachined ultrasonic transducer (PMUT), in accordance with various embodiments. Example sensors

including arrays of ultrasonic transducers are then described. Example darkfield capture is then described. Example operations for the darkfield capture are then described.

[0031] Embodiments described herein provide a method and device for darkfield capture at a sensor. It is determined whether an object is interacting with the sensor. Provided an object is not interacting with the sensor, a determination is made that a darkfield candidate image can be captured at the sensor. It is determined whether to capture a darkfield candidate image at the sensor based at least in part on the determination that a darkfield candidate image can be captured at the sensor. Responsive to making a determination to capture the darkfield candidate image, the darkfield candidate image is captured at the sensor, wherein the darkfield candidate image is an image absent an object interacting with the sensor. A darkfield estimate is updated with the darkfield candidate image.

PIEZOELECTRIC MICROMACHINED ULTRASONIC TRANSDUCER (PMUT)

[0032] Systems and methods disclosed herein, in one or more aspects provide efficient structures for an acoustic transducer (e.g., a piezoelectric actuated transducer or PMUT). One or more embodiments are now described with reference to the drawings, wherein like reference numerals are used to refer to like elements throughout. In the following description, for purposes of explanation, numerous specific details are set forth in order to provide a thorough understanding of the various embodiments. It may be evident, however, that the various embodiments can be practiced without these specific details. In other instances, well-known structures and devices are shown in block diagram form in order to facilitate describing the embodiments in additional detail.

[0033] As used in this application, the term “or” is intended to mean an inclusive “or” rather than an exclusive “or”. That is, unless specified otherwise, or clear from context, “X employs A or B” is intended to mean any of the natural inclusive permutations. That is, if X employs A; X employs B; or X employs both A and B, then “X employs A or B” is satisfied under any of the foregoing instances. In addition, the articles “a” and “an” as used in this application and the appended claims should generally be construed to mean “one or more” unless specified otherwise or clear from context to be directed to a singular form. In addition, the word “coupled” is used herein to mean direct or indirect electrical or mechanical coupling. In addition, the word “example” is used herein to mean serving as an example, instance, or illustration.

[0034] FIG. 1A is a diagram illustrating a PMUT device 100 having a center pinned membrane, according to some embodiments. PMUT device 100 includes an interior pinned membrane 120 positioned over a substrate 140 to define a cavity 130. In one embodiment, membrane 120 is

attached both to a surrounding edge support 102 and interior support 104. In one embodiment, edge support 102 is connected to an electric potential. Edge support 102 and interior support 104 may be made of electrically conducting materials, such as and without limitation, aluminum, molybdenum, or titanium. Edge support 102 and interior support 104 may also be made of dielectric materials, such as silicon dioxide, silicon nitride or aluminum oxide that have electrical connections the sides or in vias through edge support 102 or interior support 104, electrically coupling lower electrode 106 to electrical wiring in substrate 140.

[0035] In one embodiment, both edge support 102 and interior support 104 are attached to a substrate 140. In various embodiments, substrate 140 may include at least one of, and without limitation, silicon or silicon nitride. It should be appreciated that substrate 140 may include electrical wirings and connection, such as aluminum or copper. In one embodiment, substrate 140 includes a CMOS logic wafer bonded to edge support 102 and interior support 104. In one embodiment, the membrane 120 comprises multiple layers. In an example embodiment, the membrane 120 includes lower electrode 106, piezoelectric layer 110, and upper electrode 108, where lower electrode 106 and upper electrode 108 are coupled to opposing sides of piezoelectric layer 110. As shown, lower electrode 106 is coupled to a lower surface of piezoelectric layer 110 and upper electrode 108 is coupled to an upper surface of piezoelectric layer 110. It should be appreciated that, in various embodiments, PMUT device 100 is a microelectromechanical (MEMS) device.

[0036] In one embodiment, membrane 120 also includes a mechanical support layer 112 (e.g., stiffening layer) to mechanically stiffen the layers. In various embodiments, mechanical support layer 112 may include at least one of, and without limitation, silicon, silicon oxide, silicon nitride, aluminum, molybdenum, titanium, etc. In one embodiment, PMUT device 100 also includes an acoustic coupling layer 114 above membrane 120 for supporting transmission of acoustic signals. It should be appreciated that acoustic coupling layer can include air, liquid, gel-like materials, or other materials for supporting transmission of acoustic signals. In one embodiment, PMUT device 100 also includes platen layer 116 above acoustic coupling layer 114 for containing acoustic coupling layer 114 and providing a contact surface for a finger or other sensed object with PMUT device 100. It should be appreciated that, in various embodiments, acoustic coupling layer 114 provides a contact surface, such that platen layer 116 is optional. Moreover, it should be appreciated that acoustic coupling layer 114 and/or platen layer 116 may be included with or used in conjunction with multiple PMUT devices. For example, an array of PMUT devices may be coupled with a single acoustic coupling layer 114 and/or platen layer 116.

[0037] FIG. 1B is identical to FIG. 1A in every way, except that the PMUT device 100' of FIG. 1B omits the interior support 104 and thus membrane 120 is not pinned (e.g., is "unpinned"). There may be instances in which an unpinned membrane 120 is desired. However, in other instances, a pinned membrane 120 may be employed.

[0038] FIG. 2 is a diagram illustrating an example of membrane movement during activation of pinned PMUT device 100, according to some embodiments. As illustrated with respect to FIG. 2, in operation, responsive to an object proximate platen layer 116, the electrodes 106 and 108 deliver a high frequency electric charge to the piezoelectric layer 110, causing those portions of the membrane 120 not pinned to the surrounding edge support 102 or interior support 104 to be displaced upward into the acoustic coupling layer 114. This generates a pressure wave that can be used for signal probing of the object. Return echoes can be detected as pressure waves causing movement of the membrane, with compression of the piezoelectric material in the membrane causing an electrical signal proportional to amplitude of the pressure wave.

[0039] The described PMUT device 100 can be used with almost any electrical device that converts a pressure wave into mechanical vibrations and/or electrical signals. In one aspect, the PMUT device 100 can comprise an acoustic sensing element (e.g., a piezoelectric element) that generates and senses ultrasonic sound waves. An object in a path of the generated sound waves can create a disturbance (e.g., changes in frequency or phase, reflection signal, echoes, etc.) that can then be sensed. The interference can be analyzed to determine physical parameters such as (but not limited to) distance, density and/or speed of the object. As an example, the PMUT device 100 can be utilized in various applications, such as, but not limited to, fingerprint or physiologic sensors suitable for wireless devices, industrial systems, automotive systems, robotics, telecommunications, security, medical devices, etc. For example, the PMUT device 100 can be part of a sensor array comprising a plurality of ultrasonic transducers deposited on a wafer, along with various logic, control and communication electronics. A sensor array may comprise homogenous or identical PMUT devices 100, or a number of different or heterogenous device structures.

[0040] In various embodiments, the PMUT device 100 employs a piezoelectric layer 110, comprised of materials such as, but not limited to, aluminum nitride (AlN), lead zirconate titanate (PZT), quartz, polyvinylidene fluoride (PVDF), and/or zinc oxide, to facilitate both acoustic signal production and sensing. The piezoelectric layer 110 can generate electric charges under mechanical stress and conversely experience a mechanical strain in the presence of an electric field. For example, the piezoelectric layer 110 can sense mechanical vibrations caused by an ultrasonic signal and produce an electrical charge at the frequency (e.g., ultrasonic frequency)

of the vibrations. Additionally, the piezoelectric layer 110 can generate an ultrasonic wave by vibrating in an oscillatory fashion that might be at the same frequency (e.g., ultrasonic frequency) as an input current generated by an alternating current (AC) voltage applied across the piezoelectric layer 110. It should be appreciated that the piezoelectric layer 110 can include almost any material (or combination of materials) that exhibits piezoelectric properties, such that the structure of the material does not have a center of symmetry and a tensile or compressive stress applied to the material alters the separation between positive and negative charge sites in a cell causing a polarization at the surface of the material. The polarization is directly proportional to the applied stress and is direction dependent so that compressive and tensile stresses results in electric fields of opposite polarizations.

[0041] Further, the PMUT device 100 comprises electrodes 106 and 108 that supply and/or collect the electrical charge to/from the piezoelectric layer 110. It should be appreciated that electrodes 106 and 108 can be continuous and/or patterned electrodes (e.g., in a continuous layer and/or a patterned layer). For example, as illustrated, electrode 106 is a patterned electrode and electrode 108 is a continuous electrode. As an example, electrodes 106 and 108 can be comprised of almost any metal layers, such as, but not limited to, aluminum (Al)/titanium (Ti), molybdenum (Mo), etc., which are coupled with an on opposing sides of the piezoelectric layer 110.

[0042] According to an embodiment, the acoustic impedance of acoustic coupling layer 114 is selected to be similar to the acoustic impedance of the platen layer 116, such that the acoustic wave is efficiently propagated to/from the membrane 120 through acoustic coupling layer 114 and platen layer 116. As an example, the platen layer 116 can comprise various materials having an acoustic impedance in the range between 0.8 to 4 Mega Rayleigh (MRayl), such as, but not limited to, plastic, resin, rubber, Teflon, epoxy, etc. In another example, the platen layer 116 can comprise various materials having a high acoustic impedance (e.g., an acoustic impedance greater than 10 MRayl), such as, but not limited to, glass, aluminum-based alloys, sapphire, etc. Typically, the platen layer 116 can be selected based on an application of the sensor. For instance, in fingerprinting applications, platen layer 116 can have an acoustic impedance that matches (e.g., exactly or approximately) the acoustic impedance of human skin (e.g., 1.6×10^6 Rayl). Further, in one aspect, the platen layer 116 can further include a thin layer of anti-scratch material. In various embodiments, the anti-scratch layer of the platen layer 116 is less than the wavelength of the acoustic wave that is to be generated and/or sensed to provide minimum interference during propagation of the acoustic wave. As an example, the anti-scratch layer can comprise various hard and scratch-resistant materials (e.g., having a Mohs hardness of over 7 on the Mohs scale), such as, but not limited to sapphire, glass,

titanium nitride (TiN), silicon carbide (SiC), diamond, etc. As an example, PMUT device 100 can operate at 20 MHz and accordingly, the wavelength of the acoustic wave propagating through the acoustic coupling layer 114 and platen layer 116 can be 70-150 microns. In this example scenario, insertion loss can be reduced and acoustic wave propagation efficiency can be improved by utilizing an anti-scratch layer having a thickness of 1 micron and the platen layer 116 as a whole having a thickness of 1-2 millimeters. It is noted that the term "anti-scratch material" as used herein relates to a material that is resistant to scratches and/or scratch-proof and provides substantial protection against scratch marks.

[0043] In accordance with various embodiments, the PMUT device 100 can include metal layers (e.g., aluminum (Al)/titanium (Ti), molybdenum (Mo), etc.) patterned to form electrode 106 in particular shapes (e.g., ring, circle, square, octagon, hexagon, etc.) that are defined in-plane with the membrane 120. Electrodes can be placed at a maximum strain area of the membrane 120 or placed at close to either or both the surrounding edge support 102 and interior support 104. Furthermore, in one example, electrode 108 can be formed as a continuous layer providing a ground plane in contact with mechanical support layer 112, which can be formed from silicon or other suitable mechanical stiffening material. In still other embodiments, the electrode 106 can be routed along the interior support 104, advantageously reducing parasitic capacitance as compared to routing along the edge support 102.

[0044] For example, when actuation voltage is applied to the electrodes, the membrane 120 will deform and move out of plane. The motion then pushes the acoustic coupling layer 114 it is in contact with and an acoustic (ultrasonic) wave is generated. Oftentimes, vacuum is present inside the cavity 130 and therefore damping contributed from the media within the cavity 130 can be ignored. However, the acoustic coupling layer 114 on the other side of the membrane 120 can substantially change the damping of the PMUT device 100. For example, a quality factor greater than 20 can be observed when the PMUT device 100 is operating in air with atmosphere pressure (e.g., acoustic coupling layer 114 is air) and can decrease lower than 2 if the PMUT device 100 is operating in water (e.g., acoustic coupling layer 114 is water).

[0045] FIG. 3 is a top view of the PMUT device 100 of FIG. 1A having a substantially square shape, which corresponds in part to a cross section along dotted line 101 in FIG. 3. Layout of surrounding edge support 102, interior support 104, and lower electrode 106 are illustrated, with other continuous layers not shown. It should be appreciated that the term "substantially" in "substantially square shape" is intended to convey that a PMUT device 100 is generally square-shaped, with allowances for variations due to manufacturing processes and tolerances, and that slight deviation from a square shape (e.g., rounded corners, slightly wavering lines, deviations

from perfectly orthogonal corners or intersections, etc.) may be present in a manufactured device. While a generally square arrangement PMUT device is shown, alternative embodiments including rectangular, hexagon, octagonal, circular, or elliptical are contemplated. In other embodiments, more complex electrode or PMUT device shapes can be used, including irregular and non-symmetric layouts such as chevrons or pentagons for edge support and electrodes.

[0046] FIG. 4 is a simulated topographic map 400 illustrating maximum vertical displacement of the membrane 120 of the PMUT device 100 shown in FIGs. 1A-3. As indicated, maximum displacement generally occurs along a center axis of the lower electrode, with corner regions having the greatest displacement. As with the other figures, FIG. 4 is not drawn to scale with the vertical displacement exaggerated for illustrative purposes, and the maximum vertical displacement is a fraction of the horizontal surface area comprising the PMUT device 100. In an example PMUT device 100, maximum vertical displacement may be measured in nanometers, while surface area of an individual PMUT device 100 may be measured in square microns.

[0047] FIG. 5 is a top view of another example of the PMUT device 100 of FIG. 1A having a substantially circular shape, which corresponds in part to a cross section along dotted line 101 in FIG. 5. Layout of surrounding edge support 102, interior support 104, and lower electrode 106 are illustrated, with other continuous layers not shown. It should be appreciated that the term "substantially" in "substantially circular shape" is intended to convey that a PMUT device 100 is generally circle-shaped, with allowances for variations due to manufacturing processes and tolerances, and that slight deviation from a circle shape (e.g., slight deviations on radial distance from center, etc.) may be present in a manufactured device.

EXAMPLE ULTRASONIC FINGERPRINT SENSOR

[0048] FIG. 6 illustrates an example two-dimensional array 600 of square-shaped PMUT devices 601 formed from PMUT devices having a substantially square shape similar to that discussed in conjunction with FIGs. 1A, 1B, 2, and 3. Layout of square surrounding edge support 602, interior support 604, and square-shaped lower electrode 606 surrounding the interior support 604 are illustrated, while other continuous layers are not shown for clarity. As illustrated, array 600 includes columns of square-shaped PMUT devices 601 that are in rows and columns. It should be appreciated that rows or columns of the square-shaped PMUT devices 601 may be offset. Moreover, it should be appreciated that square-shaped PMUT devices 601 may contact each other or be spaced apart. In various embodiments, adjacent square-shaped PMUT devices 601 are electrically isolated. In other embodiments, groups of

adjacent square-shaped PMUT devices 601 are electrically connected, where the groups of adjacent square-shaped PMUT devices 601 are electrically isolated.

[0049] In operation, during transmission, selected sets of PMUT devices in the two-dimensional array can transmit an acoustic signal (e.g., a short ultrasonic pulse) and during sensing, the set of active PMUT devices in the two-dimensional array can detect an interference of the acoustic signal with an object (in the path of the acoustic wave). The received interference signal (e.g., generated based on reflections, echoes, etc. Of the acoustic signal from the object) can then be analyzed. As an example, an image of the object, a distance of the object from the sensing component, a density of the object, a motion of the object, etc., can all be determined based on comparing a frequency and/or phase of the interference signal with a frequency and/or phase of the acoustic signal. Moreover, results generated can be further analyzed or presented to a user via a display device (not shown).

[0050] Once an image is obtained, that image is processed by a matcher to extract features and to compare against stored images to authenticate the user. As such, accuracy of captured images is essential to the performance of image matching for user authentication. To get the best possible image for fingerprint matching, any background image or contributions to the image other than from the fingerprint should be removed or corrected for. The background image is the image obtained by the sensor when no finger is present. This background image is also referred to as the darkfield or offset. The embodiments described herein provide for capturing the darkfield image and correcting the fingerprint image for the darkfield image.

[0051] Various embodiments described herein provide a finger detection mode for identifying if an object has been placed on a fingerprint sensor. In some embodiments, if an object's presence is not detected on the fingerprint sensor, a darkfield candidate image can be captured at the sensor, where the darkfield candidate image is an image absent an object interacting with the sensor.

[0052] The disclosure recognizes and addresses, in at least certain embodiments, the issue of power consumption and a power efficient always-on approach to void detection for determining when to capture a darkfield image at the sensor. As utilized herein, a void is detected when it is determined that an object is not interacting with the sensor such that a darkfield image can be captured. The void detection stage is implemented continuously or nearly continuously and allows for the appropriate acquisition of the darkfield image.

[0053] Implementation of the low-power detection stage permits removal of physical actuation device (e.g., buttons or the like) while maintaining low power consumption. Absence of a

physical actuation device does not hinder low-power consumption and does simplify user-device interaction when sensing human touch. While embodiments of the disclosure are illustrated with reference to a mobile electronic device, the embodiments are not limited in this respect and the embodiments can be applied to any device (mobile or otherwise) having a surface that is sensitive to touch and permits or otherwise facilitates control of the device by an end-user. Such a touch-sensitive surface can embody or can constitute, for example, a fingerprint sensor. Mobile devices can be embodied in or can include consumer electronics devices (e.g., smartphones, portable gaming devices); vehicular devices (such as navigation and/or entertainment system device); medical devices; keys (e.g., for locking and gaining access to buildings, storage receptacles, cars, etc.); and the like.

[0054] When compared to conventional technologies, embodiments described herein can provide numerous improvements. For example, splitting the sensing of human touch into a low power, always-on detection stage and a triggered, full-power analysis stage permits sensing human touch continuously or nearly continuously, without causing battery drainage or other inefficiencies. Furthermore, utilizing a low power, always-on detection stage allows for the detection of voids for capturing darkfield images using the sensor.

[0055] With reference to the drawings, FIG. 7A illustrates an example of an operational environment 700 for sensing of human touch in accordance with one or more embodiments of the disclosure. As illustrated, a device 710 includes a fingerprint sensor 715 or other type of surface sensitive to touch. In one embodiment, fingerprint sensor 715 is disposed beneath a touch-screen display device of device 710. In another embodiment, fingerprint sensor 715 is disposed adjacent or close to a touch-screen display device of device 710. In another embodiment, fingerprint sensor 715 is comprised within a touch-screen display device of device 710. In another embodiment, fingerprint sensor 715 is disposed on the side or back of the device. It should be appreciated that device 710 includes a fingerprint sensor 715 for sensing a fingerprint of a finger interacting with device 710.

[0056] In one embodiment, a human finger (represented by a hand 720), can touch or interact with a specific area of device 710 proximate fingerprint sensor 715. In various embodiments, fingerprint sensor 715 can be hard and need not include movable parts, such as a sensor button configured to detect human touch or otherwise cause the device 710 to respond to human touch. The device 710 can include circuitry that can operate in response to touch (human or otherwise) of the touch-screen display device and/or fingerprint sensor 715 (or, in some embodiments, the other type of touch sensitive surface).

[0057] In accordance with the described embodiments, device 710 includes always-on circuitry 730 and system circuitry 740. It should be appreciated that components of always-on circuitry 730 and system circuitry 740 might be disposed within the same componentry, and are conceptually distinguished herein such that always-on circuitry 730 includes components that are always-on, or mostly always-on, and system circuitry 740 includes components that are powered off until they are powered on, for example, in response to an activation signal received from always-on circuitry 730. For example, such circuitry can be operatively coupled (e.g., electrically coupled, communicative coupled, etc.) via a bus architecture 735 (or bus 735) or conductive conduits configured to permit the exchange of signals between the always-on circuitry 730 and the system circuitry 740. In some embodiments, a printed circuit board (PCB) placed behind a touch-screen display device can include the always-on circuitry 730, the system circuitry 740, and the bus 735. In one embodiment, the always-on circuitry 730 and the system circuitry 740 can be configured or otherwise arranged in a single semiconductor die. In another embodiment, the always-on circuitry 730 can be configured or otherwise arranged in a first semiconductor die and the system circuitry 740 can be configured or otherwise arranged in a second semiconductor die. In addition, in some embodiments, the bus 735 can be embodied in or can include a dedicated conducting wire or a dedicated data line that connects the always-on circuitry 730 and the system circuitry 740. Always-on circuitry 730 may be a sensor processor (or included within a sensor processor) that also controls the fingerprint sensor, and system circuitry 740 may be the host processor or application processor or included within the host processor or application processor of device 710.

[0058] The always-on circuitry 730 can operate as sensor for human touch and the system circuitry 740, or a portion thereof, can permit or otherwise facilitate analysis of the human touch. As described herein, always-on circuitry 730 includes fingerprint sensor 715. For example, responsive to capturing an image of a fingerprint, fingerprint sensor 715 can transmit the captured image to system circuitry 740 for analysis.

[0059] The analysis can include fingerprint recognition or other types of biometric evaluations. The always-on circuitry 730 can be energized or otherwise power-on continuously or nearly continuously and can be configured to monitor touch of fingerprint sensor 715. In addition, in response to human touch (e.g., touch by a human finger or other human body part), the always-on circuitry 730 can be further configured to trigger detection and/or another type of analysis of elements of the human touch or a human body associated therewith. To at least that end, the always-on circuitry 730 can be configured to implement void detection for determining when to capture a darkfield image at the sensor.

[0060] FIG. 7B illustrates an example fingerprint sensor 715, in accordance with various embodiments. In one embodiment, fingerprint sensor 715 includes an array 750 of ultrasonic transducers (e.g., PMUT devices), a processor 760, and a memory 770. In various embodiments, processor 760 performs certain operations in accordance with instructions stored within memory 770. It should be appreciated that components of fingerprint sensor 715 are examples, and that certain components, such as processor 760 and/or memory 770 may not be located within fingerprint sensor 715. For example, always-on circuitry 730 or system circuitry 740 may include a processor and/or memory for performing certain operations.

[0061] In one embodiment, fingerprint sensor 715 includes processor 760 for performing the pixel capture, where pixel capture is performed using subsets of ultrasonic transducers (e.g., PMUTs) of fingerprint sensor 715. In other embodiments, processor 760 can perform at least some signal analysis, e.g., void detection, to determine whether an object has interacted with fingerprint sensor 715. In some embodiments, responsive to detecting a void at fingerprint sensor 715, a darkfield image can be captured at fingerprint sensor 715. In some embodiments, system circuitry 740 is activated in response to detecting a void for capturing the darkfield image. Subsequent the capture of the darkfield image, system circuitry 740 can be deactivated.

[0062] While the embodiment of FIG. 7B includes processor 760 and memory 770, as described above, it should be appreciated that various functions of processor 760 and memory 770 may reside in other components of device 710 (e.g., within always-on circuitry 730 or system circuitry 740). Moreover, it should be appreciated that processor 760 may be any type of processor for performing any portion of the described functionality (e.g., custom digital logic).

[0063] In various embodiments, a power supply can energize at least a portion of the system circuitry 740 according with trigger signaling (or other type of control signal) provided (e.g., generated and transmitted) by the always-on circuitry 730. For example, system circuitry 740 can include a power controller that can receive trigger signaling (e.g., a control instruction) and, in response, can energize at least one processor of the system circuitry 740 from a power-save state to a full-power state. The at least one processor that transitions from the power-save state to the full power state can execute a darkfield image capture operation in response to the void detection of always-on circuitry 730.

[0064] In various embodiments, the analysis of a darkfield image or an image of a fingerprint can include computer-accessible instruction (e.g., computer-readable instructions and/or computer-executable instructions) that in response to execution by a processor can permit or

otherwise facilitate the device 710 to implement a defined algorithm (or process) for darkfield image correction or fingerprint identification or analysis.

[0065] In various embodiments, fingerprint sensor 715 can include ultrasonic transducers (e.g., PMUTs) or capacitive micromachined ultrasonic transducers (CMUTs)) able to generate and detect acoustic/pressure waves. Examples of PMUT devices and arrays of PMUT devices are described in accordance with FIGs. 1-6 above. In embodiments, a device 710 includes fingerprint sensor 715 comprised of an array of ultrasonic transducers that can facilitate ultrasonic signal generation and sensing. For example, fingerprint sensor 715 can include a silicon wafer having a two-dimensional (or one-dimensional) array of ultrasonic transducers.

DARKFIELD ACQUISITION FOR CORRECTION OF FINGERPRINT IMAGES

[0066] Darkfield images are used for improving or correction of captured fingerprint images. As presented above, the darkfield image, also referred to as the background image or offset, is the image obtained by the sensor when no finger is present. In general, any image captured by a sensor may include temporal noise or spatial noise in addition to a signal related to an object being imaged. Temporal noise is considered as varying with time (e.g., successive images captured under similar conditions) and spatial noise is an offset that contributes to a captured signal (e.g., a ridge/valley signal). To get the best possible image for the fingerprint matcher any background image or contributions to the image other than from the fingerprint should be removed or corrected for. The embodiments described herein provide for capturing the darkfield image and using the darkfield image to correct the fingerprint image.

[0067] In various embodiments described herein, the fingerprint authentication or identification generates some constraints to the overall fingerprint sensing system. For instance, in some embodiments, a user is able to enter the authentication or identification system with no specific preparation steps. The fingerprint sensing system is in an always-on mode, waiting for the user to put his or her finger on the sensor, with no opportunities for *a priori* preparation prior to the user's finger interacting with the sensor. It is also of importance to consider that in many scenarios the fingerprint sensing system is autonomous, therefore the desire to consume as less power as possible despite the always-on mode. Since the fingerprint sensing system is capable of capturing a fingerprint at any time, the darkfield estimate used for correction should be as current as possible to provide for the best correction of the fingerprint image. In other words, in an ideal case, the darkfield image is captured just prior to a user placing their finger on the sensor. However, due to limitations on sensing and power consumption, it is not practical to actively acquire the darkfield in such a manner. Accordingly, the described embodiments provide for monitoring the darkfield such that a most current version of the darkfield estimate is

captured, for improving the quality of the fingerprint image, thus providing for improved performance of fingerprint matching.

[0068] From the sensor side, it is also to be considered that the background image or sensor offset, also referred to herein as the darkfield, is subject to change over time. For example, changes to the darkfield in the short term may be due to the influence of external parameters such as temperature, and in the longer term due to evolution of the sensor itself. It is also noted that the integration process of the sensor in the fingerprint sensing system may comprise several manufacturing steps and module construction steps that may have an impact on the background image. An overall comprehensive calibration and storage of multiple darkfield images requires many resources in terms of manufacturing calibration steps, and would also require a huge memory amount which is usually costly and not compatible with the consumer market. Moreover, this is also likely to fail technically as darkfield will evolve during the product life cycle. Therefore, there is a need for a continuous darkfield tracker that would constantly update the darkfield as time goes by.

EXAMPLE VOID DETECTION AND DARKFIELD CAPTURE

[0069] FIG. 8 illustrates a flow diagram 800 of an example method for capturing a darkfield image, according to some embodiments. Flow diagram 800 shows an overview of the different procedures involved in tracking the darkfield and then correcting a fingerprint image for the darkfield. The term darkfield and darkfield image may both be used below and represent the image captured by the sensor when no finger or object is touching the sensor. In an ideal situation, a sensor will provide a uniform darkfield when no object is present on the sensor. In the case of any actual sensor, e.g., an ultrasonic fingerprint sensor, the darkfield may be caused by ultrasound reflections within the sensor stack, and not due to any object on the sensor surface. The sensor surface (e.g., platen layer 116 of FIGs. 1A, 1B, and 2) is the part of the device where the user is expected to put his or her finger in order to measure the fingerprint.

[0070] The darkfield is measured directly at the sensor when no object such as a finger is present on the sensor surface, and as such a darkfield image is a sensor image acquired when no object is present on the sensor surface. At procedure 810 of flow diagram 800, void detection is performed. Void detection includes a determination as to whether an object is present on the sensor surface or not. Void detection is discussed on further detail below. Once the void detector has determined that there is no object on the sensor surface, a decision to capture a darkfield candidate image is made, as shown at procedure 820. The decision to capture the darkfield candidate image is optional and may be based on the monitoring of various parameters such as time and temperature. At procedure 830, a darkfield candidate

image is captured, where the darkfield candidate image includes an image (full or partial) acquired by the sensor with no object contacting or otherwise interacting with the sensor. At procedure 840, the darkfield estimate (e.g., a previously stored darkfield image) is update with the darkfield candidate image. In one embodiment, the darkfield candidate image is merged with the estimated darkfield. In another embodiment, if no previous darkfield image or darkfield estimate is stored, the darkfield candidate image is stored as the darkfield estimate. A resulting darkfield estimate is then stored, as shown at procedure 850, as an output of the merge process, and is made available for the fingerprint imaging process.

[0071] The imaging process can use the so stored darkfield estimate to correct an acquired fingerprint image. At procedure 860, a fingerprint image is acquired and at procedure 870, the fingerprint image is corrected using the stored darkfield estimate. The corrected fingerprint image may then be sent to a matcher for authentication. The matcher is the part of the fingerprint sensing system that compares the fingerprint image to the fingerprint images acquired during enrollment of the user and authenticates the user of the sensor.

[0072] In accordance with the described embodiments, the fingerprint sensor is an always-on sensor, meaning that the fingerprint sensor should always be ready to acquire a fingerprint, without the user, or another part of the system instructing the fingerprint sensor to do so (e.g., as describe in FIGs. 7A and 7B). As a result, the fingerprint sensor is constantly in operation and constantly checking if a finger is present on the sensor surface. Accordingly, there should always be a correct darkfield stored and available so that as soon as a finger is detected, the fingerprint image can be acquired and corrected for the darkfield. Many techniques exist to determine if there is a finger present on the surface, but they consist of acquiring a complete image and then determining if the image has the characteristics of a fingerprint. For an always-on sensor such techniques would require too much power and processing resources because a complete image is constantly acquired.

[0073] The void detection of the described embodiments does not require complete image acquisition and subsequent image analysis. The void detection as described herein determines whether an object is in contact with, or otherwise interacting with, the sensor surface based only on a limited number of pixels (e.g., 5-50) of the fingerprint sensor. In some embodiments, the pixels are distributed over the fingerprint sensor. This subset of pixels can form a patch or one or multiple profile(s), or can be spatially distributed on the image without any image or profile cohesion. The pixels used to in void detection may be referred to as the darkfield pixels. It should be appreciated that the more pixels used in performing void detection, the performance of void detection improves and the power consumption of the void detection increases. The

decision is a trade-off and may be adapted automatically based on the available power resources or power mode.

[0074] The subset of pixels can be analyzed, e.g., using either their temporal pattern or behavior, and/or the spatial pattern or behavior when the subset can form a patch image or a profile. For an always-on autonomous device to save power, the smaller the subset of pixels, the better it is for power consumption. A 1mA always on darkfield tracker is so consuming 24mAh per 24 hours, to be compared to a 1000mAh battery for instance. On the other side, it is also of paramount importance that the darkfield tracker system does always maintain a good enough estimate of the current darkfield to allow at any time a proper correction of the image formed on the sensor.

[0075] FIG. 9 illustrates example operation void detection associated with a two-dimensional array 900 of ultrasonic transducers, according to some embodiments. In one embodiment, the void detection includes the activation of a first subset of ultrasonic transducers for capturing single pixels (e.g., pixel 910) within a block (e.g., block 920) of two-dimensional array 900. For example, two-dimensional array 900 includes twelve blocks of 24x24 ultrasonic devices. It should be appreciated that blocks 920 are independently controllable regions of two-dimensional array 900 such that pixel acquisition can be performed concurrently for all blocks 920. The usage of blocks 920 is optional for allowing for concurrent pixel acquisition, and other methods of concurrent pixel acquisition can be utilized in the described embodiments.

[0076] As illustrated, the first phase includes activation of ultrasonic devices of the middle eight 24x24 blocks 920 of ultrasonic transducers for capturing a single pixel or a closely grouped plurality of pixels within each activated block. While the illustrated embodiment shows only eight of the twelve blocks activated, and only ultrasonic transducers activated for capturing a single pixel within the activated blocks, it should be appreciated that any number of blocks may be activated, that the pixel may be located at any position within a block, that any number of ultrasonic transducers may be activated for capturing any number of pixels, and that the illustrated embodiment is an example of many different possibilities.

[0077] The pixels may be at the same position within the blocks since this may simplify driving electronics, or different pixels may be used in the different blocks. Moreover, it should be appreciated that the two-dimensional array can include any number of ultrasonic transducers, and the two-dimensional array may be divided into any number of independently operable blocks. Furthermore, as described above, embodiments described herein provide for utilizing multiple ultrasonic transducers, some of which may be time-delayed relative to each other, to

focus a transmit beam to capture a pixel of an image. The pixels and blocks that are activated during void detection may also depend on the size of the sensor, the size of the finger, or the most likely position the user will touch the sensor. For example, for a small sensor where the finger most likely covers the entire sensor surface, pixels and blocks covering the entire surface may be activated. For larger sensors, where the finger may only cover a part of the sensor, only a central section of the sensor may be activated to save power resources. The central section may be adapted to the user, or the context of the device, e.g., the device orientation.

[0078] In the illustrated embodiment, pixel 910 is periodically captured during void detection. Although a single pixel is illustrated, it will be understood that multiple pixels can be used, either grouped together or distributed throughout the array. Also, each pixel may be imaged by activating a plurality of ultrasonic transducers around the pixel. When a significant change in ultrasonic wave receive intensity occurs due to the presence of an object positioned near a sensor platen (not shown), circuitry is activated to indicate that a void is not detected. In one embodiment, when a void is detected, a darkfield image can be captured at the fingerprint sensor using the two-dimensional array 900. In one embodiment, when a void is not detected (e.g., an object interacting with two-dimensional array 900 is detected), a darkfield image is not able to be captured using two-dimensional array 900. In one embodiment, void detection includes activating a small subset of the pixels in the array in a highly duty-cycled manner. For example, as illustrated, the 8-pixel pattern illustrated in FIG. 9 is activated. In various embodiments, these pixels are operated at a rate of 10-100 samples/second.

[0079] In some embodiments, the threshold defines an expected signal range such that signals falling within the expected signal range are indicative of no object interacting with the sensor. When a signal is outside of the expected signal range, it is determined that an object is interacting with the sensor. In one embodiment, on each transmit/receive cycle, the signal from each pixel would be compared to a mean pixel value plus/minus a threshold (e.g., an offset plus/minus a range), where the mean pixel value plus/minus the threshold is an example of the expected signal range. For example, if the signal on M or more pixels exceeds a single value, (where 'M' is a programmable setting), the system determines that an object is interacting with the fingerprint sensor, and that a void is not detected. In another example, if the signal on M or more pixels falls outside of a mean pixel value plus/minus a range, the system determines that an object is interacting with the fingerprint sensor, and that a void is not detected. Otherwise, the system determines that a void is detected. For example, in another embodiment, a sum of the received signals may be compared with a threshold, the received signals may be divided into groups and compared to a threshold, etc.

[0080] In one embodiment, the signal and mean pixel value are gray scale levels, and the threshold is plus/minus number of gray scale levels. For example, the total variance of gray scale levels could be fifteen levels, and the threshold could be plus/minus four gray scale levels. In such an example, a signal that falls outside four gray scale levels of the mean pixel value would trigger an event indicating an object is interacting with the fingerprint sensor, where a signal falling within four gray scale levels would not trigger an event (e.g., assumed to be a result of signal noise).

[0081] In order to properly identify an interaction with the fingerprint sensor, the mean pixel value is tracked over time, allowing for slow changes in signal values to not impact the determination of an object contacting the fingerprint sensor. For example, a gradual temperature change of a fingerprint sensor may impact the value of a received signal. Embodiments described herein provide for tracking the mean pixel value over time, and adjusting the threshold range accordingly, to avoid false accepts.

[0082] FIG. 10A illustrates a graph 1000 of pixel values relative to time during void detection at a sensor, according to an embodiment. For example, graph 1000 is the pixel value for pixel 910 of FIG. 9, where the pixel value for each pixel captured in FIG. 9 is received and tracked. Pixel value 1010 is received and tracked over time, where pixel value 1010 is the signal value for the pixel received from the sensor and moving average 1012 is the mean pixel value over time (e.g., running average). A first threshold, also referred to as the void flags threshold 1002, is shown. A pixel value 1010 falling outside of the range defined by void flags threshold 1002, is indicative of an event 1014 (e.g., interaction of an object with the fingerprint sensor). The threshold value may be pre-defined, or may be adaptive, e.g., based on the noise level or variance of the signal, the available resources, or the required latency. The threshold may be expressed in pixel gray levels. For example, the first threshold may be of the order of 1-10 gray levels. If the sensor signal is within the void flags threshold 1002, a void flag may be set for the pixel. This means that, based on this pixel, there is an indication that there is no object on the sensor surface. The void flags threshold 1002 may be fixed in gray levels, or may be set as a relative value of the sensor signal. The void flags threshold 1002 may also depend on other factors, e.g., the noise level, signal-to-noise level (SNR), or contrast-to-noise-level (CNR). The void flags threshold 1002 may be identical for all pixels, or may be adapted individually for each pixel. The void flags threshold 1002 can be set according to the pixel temporal noise behavior. It should be appreciated that one of ordinary skill in the art of signal processing may be able to set void flags threshold 1002 according to the probability density or distribution function of the pixel noise. For example, for a Gaussian noise distribution a void flags threshold 1002 can be set to allow for a 99% probability that the current pixel value is indeed compliant for the "noise only"

assumption. It should be appreciated that one of ordinary skill in the art of signal processing may utilize other practical experimental methods to get a correct setting of such a void flags threshold 1002. It should be appreciated that the objective is to get an overall void flag only when no object is on the sensor, to lower the probability of acquisition of a wrong darkfield candidate image, e.g., to avoid false reads of voids or objects. The void false reads rate (e.g., a void is declared and an object is on the sensor) should be kept very low, and void false rejection rate (e.g., a void is not declared and no object is on the sensor) can be kept high, as long as from time to time, a void is correctly declared.

[0083] Moving average 1012 is updated over time to account for environmental or other changes that impact signal values (e.g., temperature change). In one embodiment, if a pixel value 1010 falls within moving average threshold 1004, moving average 1012 is updated by averaging the pixel value 1010 with the previous moving average 1012, resulting in an updated moving average 1012. It should be appreciated that pixel value 1010 can be averaged with a number of previous values of moving average 1012, so as to control the impact of pixel value 1010 on moving average 1012. Updating moving average 1012, and thus void flags threshold 1002, allows for (e.g., slow) temporal evolution of factors impacting pixel signal values (e.g., temperature change).

[0084] The determination whether there is no object on the sensor surface, e.g., a void is detected, may be based on a combination of the plurality of pixels. For example, a void may be detected only if all the plurality of pixels have a void flag, meaning that for all pixels, the sensor signal for that pixel was within the void flags threshold 1002 of the moving average 1012. This will limit the void false alarm rate. Instead of all pixels have a void flag, it may be required that only a certain percentage of the pixels have a void flag (e.g., 50%-100%). In some embodiments, this is a voting scheme, where all pixels have a vote on the void status, and a final decision is made. Other techniques fusing the multiple pixel information can be used. The void flag can be updated for each sample of the pixels temporal input.

[0085] Once a void is detected, thanks to the subsequent steps of the darkfield tracker, the system may then acquire an image of the complete sensor by activating pixel acquisition over the entire two-dimensional array to capture the pixels of the image (or a decimated image), resulting in the capture of a darkfield candidate image. Alternatively, and beneficial for power, once a void is detected, the decision to capture a darkfield candidate image may also depend on other factors, e.g., the time passed since the last darkfield candidate image acquisition, the temperature change since the last darkfield candidate image acquisition, the available power resources or power mode of the device. When it is known that the overall system is already in a

high-power mode (such as when a user interacts with his smartphone, so the application processor is on, and/or the screen is on), one can allow for more power consumption for the darkfield tracker and allow for more frequent updates. Alternatively, the settings of the darkfield tracker may also depend on an application running on the system that may have certain requirements on fingerprint image quality. For example, a banking application may need a high-quality fingerprint image, and the darkfield tracker may be configured accordingly. The different factors may also be combined to determine an urgency of the darkfield acquisition, and their weight may be different. For example, temperature change is known to affect the darkfield, so a change in temperature may be an important factor in determining whether a new darkfield is acquired. The temperature may be measured by a temperature sensor built into the fingerprint sensor, and may come from another temperature sensor in the device containing the fingerprint sensor.

[0086] FIG. 10A also shows a second threshold, also referred to as the moving average threshold 1004. Moving average 1012 is updated over time to account for environmental or other changes that impact signal values (e.g., temperature change). The moving average threshold 1004 range (e.g., 5-50) is shown here to have a larger value than the void flags threshold 1002 range. When the sensor signal passes outside the moving average threshold 1004 range (e.g. as indicated by event 1014), it may be an indication that there may be an object on the sensor surface. In one embodiment, if a pixel value 1010 falls within moving average threshold 1004, moving average 1012 is updated by averaging the pixel value 1010 with the previous moving average 1012, resulting in an updated moving average 1012 and if a pixel value falls outside of moving average threshold 1004 (e.g., at event 1014), moving average 1012 is not updated. It should be appreciated that pixel value 1010 can be averaged with a number of previous values of moving average 1012, so as to control the impact of pixel value 1010 on moving average 1012. Updating moving average 1012, and thus void flags threshold 1002, allows for (e.g., slow) temporal evolution of factors impacting pixel signal values (e.g., temperature change). In the present embodiment, when an object is placed on the sensor, the change in signal due to this event is much faster than any slow temporal evolution. The timescale of the averaging should therefore be larger than the timescale of the signal change due to the sudden presence of an object. Furthermore, the time scale of the averaging is adapted to the expected timescale of the temporal evolutions, e.g., due to temperature changes. After event 1014, the average may be reset so as to obtain an accurate average as soon as possible.

[0087] In one embodiment, responsive to event 1014, determination of moving average 1012 is stopped so as to avoid influencing or modifying moving average 1012 by any signal due to an

object on the sensor surface. The void flags threshold 1002 is set to capture an object being put on the sensor and the system can use *a priori* knowledge that whenever an object is set on the sensor, the only possible variation of the pixel level is either negative or positive. This *a priori* information can be used to build a non-symmetrical threshold detector.

[0088] It should be appreciated that one of ordinary skill in the art of signal processing would understand how to calculate a moving average from a set of temporal values of an input signal. For the sake of memory space and calculus cost, it may be beneficial to use a recursive filter to implement such a moving average.

[0089] This stage where the moving average is stopped is indicated by the horizontal line at event 1014 once the pixel value 1010 goes beyond moving average threshold 1004. Moving average 1012 may be stopped for all darkfield pixels when at least one pixel indicates that the signal was outside moving average threshold 1004. Alternatively, this decision may be made when a predefined portion (e.g. <20%) of the darkfield pixels indicated that the pixel value 1010 was outside moving average threshold 1004. Similar to void flags threshold 1002, moving average threshold 1004 may be defined by several methods. It is beneficial that moving average threshold 1004 is larger than void flags threshold 1002. As explained above, the moving average thresholding method may be symmetrical compared to the moving average, or may be asymmetrical. Note that in the case of an ultrasound sensor, when there is no object on the sensor surface, the signal intensity is high because the signal reflected from the sensor surface is high due to the high acoustic impedance at the boundary with the air. When an object is present on the sensor surface, some of the acoustic waves may enter into the object, and thus less signal is reflected. Although this is a matter of convention it is usual that a ridge or any object on the sensor generates a darker value compared to air. Therefore, when an object is present on the sensor surface, the signal decreases, as indicated in FIG. 10A.

[0090] FIG. 10A also shows that when the object/finger is removed, as indicated at event 1016, the signal intensity increases again. Once the signal is within moving average threshold 1004, the moving average 1012 is updated again, as illustrated. Furthermore, once the signal is within the void flags threshold 1002, the void flags are regenerated. The void flags threshold 1002 and moving average threshold 1004 may be different whether the sensor signal is within or outside the threshold, thereby creating some sort of hysteresis. It may be beneficial to allow for an evolving threshold for at least the moving average threshold 1004, to make it more probable to catch the moment when the sensor is void again.

[0091] When a finger is in close contact with the sensor, the temperature of the sensor may change due to thermal conduction. This may increase or decrease the temperature of the sensor significantly, e.g., changing reflections within the sensor stack, so that the darkfield is affected. FIG. 10B shows an example graph 1020 of a signal value when a finger maintains contact with the sensor. Pixel value 1022 is received and tracked over time, where pixel value 1022 is the signal value for the pixel received from the sensor and moving average 1024 is the mean pixel value over time (e.g., running average). The pixel value 1022 of the sensor signal decreases over time, starting at event 1026 (finger contacts surface), due to changes in the sensor system caused by a temperature change. For example, the temperature change may change the properties of the material of the sensor and may change the speed of sound in the materials, and/or may create mechanical stress in the materials and so big enough mechanical distortions in these material, which can thereby impact reflections and the timing characteristics of the signal acquisition. When the finger is removed, as shown at event 1028, the temperature does not change immediately back to the value before the contact. As a consequence, when the finger is removed, the pixel value 1022 increases again, but the increase is not sufficient to get the signal within moving average threshold 1032. This means that the moving average 1024 is not activated, and the algorithm is blocked/frozen since the moving average is used for determining voids using void flags threshold 1030. The pixel value 1022 may slowly get back to within moving average threshold 1032 as the temperature slowly changes, however, these may cause the algorithm to not work properly for an unacceptable time period.

[0092] In another embodiment, the effect of the temperature on the moving average is predicted, as illustrated in graph 1040 of FIG. 10C. For example, in periods when the signal is within the void flags threshold 1050, the system may monitor the pixel value 1042 and the temperature change, and determine any possible correlation. As such, the expected pixel value 1044 for the darkfield pixels as a function of temperature is determined and stored. This correlation scheme can be obtained during normal use of the system or prior to the sensor system is launched in its final stage through a manufacturing calibration analysis step. If a strong enough correlation is found, the expected pixel value 1044 may be corrected for a change in temperature during the period of finger touch (e.g., between events 1046 and 1048). Void flags threshold 1050 is determined based on the expected pixel value 1044 when a finger is touching the sensor and is based on the moving average 1043 when a finger is not touching the sensor. When pixel value 1042 falls outside of moving average threshold 1052, moving average 1043 is not determined. The application of the correction may depend on the confidence in the correlation. These effects may be determined on a pixel basis, or on a sensor basis, e.g., by averaging effect for the different pixels. In such an embodiment, the expected pixel value 1044 and the associated void flags threshold 1050 would not be horizontal during

the period of finger touch (between events 1046 and 1048), but would be modified based on the observed correlation, and follow the temperature dependence of the pixel value (sensor signal) 1042 more closely. Once the finger is lifted, as shown at event 1048, the algorithm would not be frozen because, if the correction was accurate enough, the pixel value 1042 would again be within the void flags threshold 1050.

[0093] FIG. 10D illustrates an example graph 1060 of a signal value when a finger maintains contact with the sensor including a timer, according to embodiments. In some embodiment, a timer (e.g., 5-20 seconds) is introduced. It should be appreciated that the timer may be based on a predetermined time, e.g., the maximum time a user would be expected to keep their finger on the sensor, and may be dependent on the type of application being used and the context of the electronic device, e.g., activity of user, motion of device including the sensor. This timer is activated as soon as an object is detected on the sensor surface (at event 1066), as shown in FIG. 10C. This timer allows to reactivate the moving average 1064 after a predefined period, irrespective of the pixel value 1062. At event 1068 the object is removed from the sensor surface, but pixel value 1062 remains outside moving average threshold 1074. Using a timer, at event 1070 moving average 1064 acquisition is restarted, thereby adjusting void flags threshold 1072 and moving average threshold 1074. In one embodiment, upon the timer lapsing, a verification operation may be performed to analyze the image for characteristics of a fingerprint or object. If the verification operation indicates that a finger or other object is interacting with the sensor, the timer can be restarted or set for a longer time period to allow for the finger or object to be removed from the sensor.

[0094] In another embodiment, an Object up (or Finger up) detector is implemented within the sensor. This is to compensate for the possible drift in the pixel values during which an object has been put on the sensor as explained above and the need for a watchdog mechanism. The Object or Finger up detector is a reversed function of the Object or Finger down detector, that stops the moving average mechanism as soon as the current pixel value is outside the boundaries. Here, as soon as the moving average is stopped, a second moving average is initialized so as to capture the pixel average value while the first moving average is stopped and so when an Object or Finger is assumed on the sensor. The current pixel value is then compared, to the second moving average with a threshold principle similar to the thresholding explained above in FIGs. 10A through 10D. As soon as the current pixel value is considered outside the allowed boundaries, for the considered pixel, an Object or Finger up detection event is considered and can unblock the first moving average. A change in the second moving average (e.g., due to temperature variation) may also be used to correct to first moving average after the Object or Finger up event is detected. The boundaries/thresholds benefit again to be

asymmetrical that is use the *a priori* information that Object or Finger lift will only increase the pixel value (according to the convention where a finger or object put on the sensor can only decrease the pixel value). So, with this option, either the pixel value back to the moving average threshold (as explained above) or the Object or Finger up detector explained here can reactivate the moving average and the void detector. The Object or Finger up detector will also benefit from a voting scheme for all the pixels that are used in the void detector.

[0095] In another embodiment, temperature calibration of the subset of darkfield pixels used in the void detector is implemented. While the present embodiment is described as using temperature calibration, it should be appreciated that other parameters may be used in a similar manner. As discussed above, the expected pixel value of the darkfield pixels may be determined as a function of temperature. A table or other type of register is generated into which the expected darkfield values of the pixels are stored for each temperature or some temperature steps. This table consumes memory space, on one side, but remains very small compared to the more conventional principle to store all the darkfield values for all the pixels in the image for each temperature step. The expected darkfield pixels values as a function of temperature can be used to determine if an object is interacting with the sensor. Figure 10E illustrates example graph 1080. The figure shows expected pixel value 1084 which changes over time as the temperature of the sensor changes. Expected pixel value 1084 is determined by measuring the temperature of the sensor, and then retrieving expected pixel value 1084 from memory based on the previously determined relation. The figure shows that when the finger is on the sensor, the temperature changes, e.g. by thermal conduction of the heat of the finger, which causes the expected pixel value to change. Void flags threshold 1090 is used in a similar matter as above to determine if an object is interacting with the sensor. When the pixel value is within void flags threshold 1090 around expected pixel value 1084, it is determined that no object is interacting with the sensor. On the other hand, when the pixel value is outside void flags threshold 1090 around expected pixel value 1084, for example at event 1086, it is determined that an object is interacting with the sensor. Because the expected pixel value is tracked as a function of temperature, when the finger is removed from the sensor, at event 1088, the pixel value falls again within void flags threshold 1090 around expected pixel value 1084, as seen in the figure. The void detector is so made robust to temperature changes, and the back to void state is also made robust. The temperature darkfield values can be filled in at some manufacturing calibration stage, or be filled in and updated during the product's life cycle. For example, when a void is detected and a temperature is read and is stable enough, the moving average value can be stored into the temperature pixel darkfield table. It can then be used either only for the back to void detection or whenever available for the non-void detection step. Combinations of the two techniques may be used depending on the context, application,

and the reliability of the prediction of the expected darkfield pixel values. When reliable predictions can be made using the temperature, or even additional parameters, this technique can be very robust. In other embodiments, other techniques may be used to determine the expected darkfield value dependence on temperature, and other factors if needed. For example, in an initial stage imaging techniques may be used to determine if an object is interacting with the sensor, while the expected darkfield value dependence on temperature is determined. These imaging techniques consume more resources. However, as soon as the expected darkfield value dependence on temperature has been determined, the imaging techniques are no longer required.

[0096] It should be appreciated that for the void detector there should be a very high certainty that there is no object on the sensor before deciding to measure a darkfield. It is better to be conservative, and that when there is doubt, to decide not to declare a void is detected. This aspect is also illustrated by the fact that all darkfield pixels must be within the void flags threshold to indicate if a void is detected. Furthermore, it takes only one, or a few, pixels to be above the moving average threshold to stop the moving average in order to limit the change that an object on the sensor corrupts the darkfield image determination. The settings of the different threshold and conditions should reflect this principle. The settings may be adapted, e.g., to the different users, or the usage context.

[0097] FIG. 11 illustrates a flow diagram 1100 of a method for void detection, according to various embodiments. It should be appreciated that not all procedures may be required, additional procedures may be performed, or the procedures may be performed in a different order. As is shown, at procedure 1110, the pixel value (sensor signal) is acquired for the darkfield pixels, e.g., in a continuous temporal manner. At procedure 1120, it is determined whether the pixel value is outside the moving average threshold. If the sensor signal is outside the moving average threshold, as shown at procedure 1130, no void is detected (an object is detected). Flow diagram 1100 then returns to procedure 1110. If the sensor signal is not outside the moving average threshold, as shown at procedure 1140, the moving average is updated.

[0098] At procedure 1150, it is determined whether the pixel value is outside the void flags threshold. If the sensor signal is outside the void flags threshold, as shown at procedure 1160, no void is detected (an object is detected). Flow diagram 1100 then returns to procedure 1110. If the sensor signal is not outside the void flags threshold, as shown at procedure 1170, a void is detected. Flow diagram 1100 then returns to procedure 1110. In one embodiment, a darkfield image is captured.

[0099] In some embodiments, after the void detector has determined a void status, and a darkfield candidate image has been captured, the darkfield may be merged with a previously determined darkfield image. It should be appreciated that capturing the darkfield candidate image may also be subject to satisfying a time delay since last darkfield capture or temperature change.

[0100] In one embodiment, as soon as the darkfield candidate image is captured, a test that the darkfield candidate image is indeed a darkfield image can be performed. This test can look for structures in the image to distinguish an actual darkfield image from a fingerprint image or an object image. An additional darkfield quality verification step may be applied before merging the recently acquired darkfield candidate image. For example, an image analysis may be applied to scan for any image contribution that are not likely to constitute a darkfield. The image analysis may comprise looking for features resembling a fingerprint, or spatial frequencies related to a fingerprint. If such features are present, the darkfield candidate image may not be used, or used with a lesser weight. A darkfield quality factor may be determined, and the weight of the candidate darkfield in the merger may depend on the quality factor. The quality factor may also express a confidence in the fact that no object was detected. It may also be determined if the quality of the darkfield estimate will be negatively affected by the merger of the darkfield candidate image, and based on this determination, the weight of the darkfield candidate image may be adapted. The stored darkfield estimate may be subtracted from the recently acquired darkfield candidate image, since this represent the latest acquired image of the sensor. If the darkfield procedure is working properly, the so obtained corrected image should be nearly uniform but for a small contribution. The uniformity of quality of the image may be determined to analysis the quality of the darkfield correction, and any issue or errors may be used as feedback to automatically adapt the darkfield correction process.

[0101] In one embodiment, the darkfield estimate is updated. In some embodiments, only the last acquired darkfield candidate image may be used, without performing any merging. In other embodiments, the darkfield candidate image is merged with previously recorded darkfield images as the darkfield estimate. The darkfield estimate provides a gradual evolution of the darkfield and allows for a reduction of the temporal noise that is captured with the darkfield candidate image. The merging may be implemented as averaging the darkfield candidate image into the darkfield estimate. This may reduce, or remove, the temporal noise contribution. Many different types of averaging or merging may be used. For example, a recursive average filter may be used where the latest darkfield candidate image contribute with more weight than older darkfield candidate images.

[0102] In some embodiments, after the darkfield candidate image is merged with the darkfield estimate, and the darkfield estimate is stored, the stored darkfield estimate may be used in the darkfield correction of acquired images containing a fingerprint. Once the sensor determines that a finger is present on the sensor, and that a fingerprint image is acquired, the stored darkfield estimate may be subtracted from the fingerprint image to perform the darkfield correction. A quality verification may be applied to make sure the darkfield correction actually improves the image quality of the fingerprint image. For example, the CNR of the ridge/valley pattern should improve due to the darkfield correction.

EXAMPLE OPERATIONS FOR DARKFIELD TRACKING

[0103] FIGs. 12 through 14 illustrate flow diagrams of example methods for darkfield tracking according to various embodiments. Procedures of these methods will be described with reference to elements and/or components of various figures described herein. It is appreciated that in some embodiments, the procedures may be performed in a different order than described, that some of the described procedures may not be performed, and/or that one or more additional procedures to those described may be performed. The flow diagrams include some procedures that, in various embodiments, are carried out by one or more processors (e.g., a host processor or a sensor processor) under the control of computer-readable and computer-executable instructions that are stored on non-transitory computer-readable storage media. It is further appreciated that one or more procedures described in the flow diagrams may be implemented in hardware, or a combination of hardware with firmware and/or software.

[0104] With reference to FIG. 12, flow diagram 1200 illustrates an example method for darkfield tracking, according to various embodiments. In one embodiment, the method of flow diagram 1200 is performed at a fingerprint sensor. At procedure 1210 of flow diagram 1200, a pixel value is received. At procedure 1220, it is determined whether an object is interacting with the sensor. In one embodiment, procedure 1220 is performed according to flow diagram 1300 of FIG. 13. In another embodiment, procedure 1220 is performed according to flow diagram 1400 of FIG. 14.

[0105] Flow diagram 1300 of FIG. 13 illustrates an example method for determining whether an object is interacting with the sensor. At procedure 1310, signals are transmitted at ultrasonic transducers of the ultrasonic sensor. At procedure 1320, reflected signals are received at ultrasonic transducers of the ultrasonic sensor. At procedure 1330, provided the signals are not indicative of an object interacting with the ultrasonic sensor, it is determined that an object is not

interacting with the ultrasonic sensor. In one embodiment, the reflected signals are compared to a void flags threshold around a moving average. Provided the reflected signals are within the void flags threshold, it is determined that the reflected signals are not indicative of an object interacting with the ultrasonic sensor. In one embodiment, the moving average is updated provided the signals are within a moving average threshold, wherein the moving average threshold is larger than the void flags threshold. In one embodiment, provided the reflected signals are within the void flags threshold, a determination is made that an object is not interacting with the ultrasonic sensor and that a darkfield candidate image can be captured at the sensor. Similar embodiments are described above with reference to flow diagram 1100 of FIG. 11. In one embodiment, provided an object is interacting with the sensor, an object lifting signal is generated when it is determined the object is no longer interacting with the sensor.

[0106] In one embodiment, provided an object is interacting with the sensor, a determination is made that a darkfield candidate image cannot be captured at the sensor. In one embodiment, responsive to making the determination that a darkfield candidate image cannot be captured at the sensor, a timer is activated. Responsive to a predetermined period of the timer lapsing, the determining whether an object is interacting with the sensor is repeated. In another embodiment, responsive to making the determination that a darkfield candidate image cannot be captured at the sensor, a signal received at the sensor is compared to a sensor temperature correlation scheme. Signal thresholds are modified according to the sensor temperature correlation scheme during the determining whether an object is interacting with the sensor. In one embodiment, an expected signal value as described in FIG. 10C can be used.

[0107] Flow diagram 1400 of FIG. 14 illustrates another example method for determining whether an object is interacting with the sensor. At procedure 1410, a temperature of the sensor is measured. At procedure 1420, the pixel value (e.g., received at procedure 1210) is compared to an expected pixel value based on the temperature. At procedure 1430, it is determined whether an object is interacting with the sensor based on the comparing the pixel value to an expected pixel value based on the temperature of the sensor. In one embodiment, a pixel value is received for a plurality of pixels.

[0108] With reference to FIG. 12, if it is determined that an object is not interacting with the sensor, flow diagram 1200 proceeds to procedure 1230. At procedure 1230, it is determined whether to capture a darkfield candidate image at the sensor based at least in part on the determination that a darkfield candidate image can be captured at the sensor. In one embodiment, the determination to capture the darkfield candidate image is also based at least in part on making a determination that a minimum amount of time has passed since a most

recent darkfield candidate image capture. For example, if a darkfield candidate image was recently captured, it may not be necessary to capture another darkfield candidate image as there would be none or negligible changes. In another embodiment, the determination to capture the darkfield candidate image is also based at least in part on making a determination that a temperature change since a most recent darkfield candidate image capture has exceeded a temperature threshold. For example, if the temperature has been relatively constant, it may not be necessary to capture another darkfield candidate image as there would be none or negligible changes. It should be appreciated that in some embodiments, the determination to capture the darkfield candidate image may be based on a combination of time passed since the last darkfield candidate image was captured and the temperature of the sensor.

[0109] In one embodiment, provided an object is not interacting with the sensor, a temperature of the sensor is determined. The temperature is associated with a corresponding pixel value. The temperature and pixel value pair are then stored, e.g., as an expected pixel value. For example, the temperature and pixel value pair can be used in determining an expected pixel value of flow diagram 1400.

[0110] If it is not determined that a darkfield candidate image should be captured, flow diagram 1200 returns to procedure 1210. In one embodiment, flow diagram 1200 delays the performance of procedure 1210 a predetermined time period, e.g., to ensure that enough time has passed that a darkfield candidate image could be captured, given satisfaction of other conditions. If it is determined that a darkfield candidate image should be captured, flow diagram 1200 proceeds to procedure 1240.

[0111] At procedure 1240, a darkfield image is captured as a darkfield candidate image, where a darkfield image is an image absent an object interacting with the sensor. At procedure 1250, the darkfield estimate is updated with the darkfield candidate image. In one embodiment, as shown at procedure 1255, the darkfield candidate image is merged with the darkfield estimate. In one embodiment, as shown at procedure 1260, provided the darkfield estimate is not stored, the darkfield candidate image is stored as the darkfield estimate.

[0112] In one embodiment, if it is determined that an object is interacting with the sensor at procedure 1220, flow diagram 1200 also proceeds to procedure 1270, where an image of the object is captured. In one embodiment, where the object is a finger, a fingerprint image is captured. At procedure 1280, the image is corrected using the darkfield estimate.

[0113] What has been described above includes examples of the subject disclosure. It is, of course, not possible to describe every conceivable combination of components or methodologies for purposes of describing the subject matter, but it is to be appreciated that many further combinations and permutations of the subject disclosure are possible. Accordingly, the claimed subject matter is intended to embrace all such alterations, modifications, and variations that fall within the spirit and scope of the appended claims.

[0114] In particular and in regard to the various functions performed by the above described components, devices, circuits, systems and the like, the terms (including a reference to a "means") used to describe such components are intended to correspond, unless otherwise indicated, to any component which performs the specified function of the described component (e.g., a functional equivalent), even though not structurally equivalent to the disclosed structure, which performs the function in the herein illustrated exemplary aspects of the claimed subject matter.

[0115] The aforementioned systems and components have been described with respect to interaction between several components. It can be appreciated that such systems and components can include those components or specified sub-components, some of the specified components or sub-components, and/or additional components, and according to various permutations and combinations of the foregoing. Sub-components can also be implemented as components communicatively coupled to other components rather than included within parent components (hierarchical). Additionally, it should be noted that one or more components may be combined into a single component providing aggregate functionality or divided into several separate sub-components. Any components described herein may also interact with one or more other components not specifically described herein.

[0116] In addition, while a particular feature of the subject innovation may have been disclosed with respect to only one of several implementations, such feature may be combined with one or more other features of the other implementations as may be desired and advantageous for any given or particular application. Furthermore, to the extent that the terms "includes," "including," "has," "contains," variants thereof, and other similar words are used in either the detailed description or the claims, these terms are intended to be inclusive in a manner similar to the term "comprising" as an open transition word without precluding any additional or other elements.

[0117] Thus, the embodiments and examples set forth herein were presented in order to best explain various selected embodiments of the present invention and its particular application and

to thereby enable those skilled in the art to make and use embodiments of the invention. However, those skilled in the art will recognize that the foregoing description and examples have been presented for the purposes of illustration and example only. The description as set forth is not intended to be exhaustive or to limit the embodiments of the invention to the precise form disclosed.

[0118] As short summaries, this writing has disclosed the following broad concepts:

Concept 1. A method for darkfield tracking at a sensor, the method comprising:
determining whether an object is interacting with the sensor;
provided an object is not interacting with the sensor, making a determination that a darkfield candidate image can be captured at the sensor;
determining whether to capture a darkfield candidate image at the sensor based at least in part on the determination that a darkfield candidate image can be captured at the sensor;
responsive to making a determination to capture the darkfield candidate image, capturing the darkfield candidate image at the sensor, wherein the darkfield candidate image is an image absent an object interacting with the sensor; and
updating a darkfield estimate with the darkfield candidate image.

Concept 2. The method of Concept 1, wherein the determination to capture the darkfield candidate image is also based at least in part on making a determination that a minimum amount of time has passed since a most recent darkfield candidate image capture.

Concept 3. The method of Concept 1, wherein the determination to capture the darkfield candidate image is also based at least in part on making a determination that a temperature change since a most recent darkfield candidate image capture has exceeded a temperature threshold.

Concept 4. The method of Concept 1, further comprising:
provided an object is interacting with the sensor, generating an object lifting signal when it is determined the object is no longer interacting with the sensor.

Concept 5. The method of Concept 1, wherein the updating the darkfield estimate with the darkfield candidate image comprises:
merging the darkfield candidate image with the darkfield estimate.

Concept 6. The method of Concept 1, wherein the updating the darkfield estimate with the darkfield candidate image comprises:

provided the darkfield estimate is not stored, storing the darkfield candidate image as the darkfield estimate.

Concept 7. The method of Concept 1, wherein the sensor is an ultrasonic sensor, wherein the determining whether an object is interacting with the sensor comprises:
transmitting signals at ultrasonic transducers of the ultrasonic sensor;
receiving reflected signals at ultrasonic transducers of the ultrasonic sensor; and
provided the signals are not indicative of an object interacting with the ultrasonic sensor, determining that an object is not interacting with the ultrasonic sensor.

Concept 8. The method of Concept 7, further comprising:
comparing the reflected signals to a void flags threshold around a moving average; and
provided the reflected signals are within the void flags threshold, determining that the signals are not indicative of an object interacting with the ultrasonic sensor.

Concept 9. The method of Concept 8, further comprising:
updating the moving average provided the signals are within a moving average threshold, wherein the moving average threshold is larger than the void flags threshold.

Concept 10. The method of Concept 8, further comprising:
provided the reflected signals are within the void flags threshold, making the determination that a darkfield candidate image can be captured at the sensor.

Concept 11. The method of Concept 1, further comprising:
responsive to detecting an object interacting with the sensor, capturing an image comprising the object; and
correcting the image using the darkfield estimate.

Concept 12. The method of Concept 1, further comprising:
provided an object is interacting with the sensor, making the determination that a darkfield candidate image cannot be captured at the sensor.

Concept 13. The method of Concept 12, further comprising:
responsive to making the determination that a darkfield candidate image cannot be captured at the sensor, activating a timer; and
responsive to a predetermined period of the timer lapsing, repeating the determining whether an object is interacting with the sensor.

Concept 14. The method of Concept 12, further comprising:
responsive to making the determination that a darkfield candidate image cannot be captured at the sensor, comparing a signal received at the sensor to a sensor temperature correlation scheme; and
modifying signal thresholds according to the sensor temperature correlation scheme during the determining whether an object is interacting with the sensor.

Concept 15. The method of Concept 1, further comprising:
provided an object is not interacting with the sensor:
determining a temperature of the sensor;
associating the temperature with a corresponding pixel value; and
storing the temperature and pixel value pair.

Concept 16. The method of Concept 1, wherein determining whether an object is interacting with the sensor comprises:
measuring a temperature of the sensor;
receiving a pixel value for a pixel of the sensor;
comparing the pixel value to an expected pixel value based on the temperature of the sensor; and
determining whether an object is interacting with the sensor based on the comparing the pixel value to an expected pixel value based on the temperature of the sensor.

Concept 17. The method of Concept 16, wherein the pixel value is received for a plurality of pixels/.

Concept 18. An electronic device comprising:
a fingerprint sensor;
a memory; and
a processor configured to:
determine whether an object is interacting with the fingerprint sensor;
provided an object is not interacting with the sensor, make a determination that a darkfield candidate image can be captured at the sensor;
determine whether to capture a darkfield candidate image at the sensor based at least in part on the determination that a darkfield candidate image can be captured at the sensor;

responsive to making a determination to capture the darkfield candidate image, capture the darkfield candidate image at the sensor, wherein the darkfield candidate image is an image absent an object interacting with the sensor; and
update a darkfield estimate with the darkfield candidate image.

Concept 19. The electronic device of Concept 18, wherein the processor is further configured to:

merge the darkfield candidate image with the darkfield estimate.

Concept 20. The electronic device of Concept 18, wherein the fingerprint sensor is an ultrasonic fingerprint sensor, wherein the processor is further configured to:

transmit signals at ultrasonic transducers of the ultrasonic sensor;
receive reflected signals at ultrasonic transducers of the ultrasonic sensor; and
provided the signals are not indicative of an object interacting with the ultrasonic sensor, determine that an object is not interacting with the ultrasonic sensor

Concept 21. The electronic device of Concept 18, wherein the processor is further configured to:

responsive to detecting an object interacting with the fingerprint sensor, capture an image comprising the object; and
correct the image using the darkfield estimate.

Concept 22. The electronic device of Concept 21, wherein the processor is further configured to:

forward the image to a matcher for authentication.

Concept 23. A non-transitory computer readable storage medium having computer readable program code stored thereon for causing a computer system to perform a method for darkfield tracking at a sensor, the method comprising:

determining whether an object is interacting with the sensor;
provided an object is not interacting with the sensor, making a determination that a darkfield candidate image can be captured at the sensor;
determining whether to capture a darkfield candidate image at the sensor based at least in part on the determination that a darkfield candidate image can be captured at the sensor;
responsive to making a determination to capture the darkfield candidate image, capturing the darkfield candidate image at the sensor, wherein the darkfield candidate image is an image absent an object interacting with the sensor;

updating a darkfield estimate with the darkfield candidate image;
responsive to detecting an object interacting with the sensor, capturing an image comprising the object; and
correcting the image using the darkfield estimate.

Concept 24. The non-transitory computer readable storage medium of Concept 23, wherein the updating the darkfield estimate with the darkfield candidate image comprises:
merging the darkfield candidate image with the darkfield estimate.

Concept 25. The non-transitory computer readable storage medium of Concept 23, wherein the sensor is an ultrasonic sensor, wherein the determining whether an object is interacting with the sensor comprises:
transmitting signals at ultrasonic transducers of the ultrasonic sensor;
receiving reflected signals at ultrasonic transducers of the ultrasonic sensor; and
provided the signals are not indicative of an object interacting with the ultrasonic sensor, determining that an object is not interacting with the ultrasonic sensor.

CLAIMS

What is claimed is:

1. A method for darkfield tracking at a sensor, the method comprising:
determining whether an object is interacting with the sensor;
provided an object is not interacting with the sensor, making a determination that a darkfield candidate image can be captured at the sensor;
determining whether to capture a darkfield candidate image at the sensor based at least in part on the determination that a darkfield candidate image can be captured at the sensor;
responsive to making a determination to capture the darkfield candidate image, capturing the darkfield candidate image at the sensor, wherein the darkfield candidate image is an image absent an object interacting with the sensor; and
updating a darkfield estimate with the darkfield candidate image.
2. The method of Claim 1, wherein the determination to capture the darkfield candidate image is also based at least in part on making a determination that a minimum amount of time has passed since a most recent darkfield candidate image capture.
3. The method of Claim 1, wherein the determination to capture the darkfield candidate image is also based at least in part on making a determination that a temperature change since a most recent darkfield candidate image capture has exceeded a temperature threshold.
4. The method of Claim 1, further comprising:
provided an object is interacting with the sensor, generating an object lifting signal when it is determined the object is no longer interacting with the sensor.
5. The method of Claim 1, wherein the updating the darkfield estimate with the darkfield candidate image comprises:
merging the darkfield candidate image with the darkfield estimate.
6. The method of Claim 1, wherein the updating the darkfield estimate with the darkfield candidate image comprises:
provided the darkfield estimate is not stored, storing the darkfield candidate image as the darkfield estimate.

7. The method of Claim 1, wherein the sensor is an ultrasonic sensor, wherein the determining whether an object is interacting with the sensor comprises:
transmitting signals at ultrasonic transducers of the ultrasonic sensor;
receiving reflected signals at ultrasonic transducers of the ultrasonic sensor; and
provided the signals are not indicative of an object interacting with the ultrasonic sensor,
determining that an object is not interacting with the ultrasonic sensor.

8. The method of Claim 7, further comprising:
comparing the reflected signals to a void flags threshold around a moving average; and
provided the reflected signals are within the void flags threshold, determining that the signals are not indicative of an object interacting with the ultrasonic sensor.

9. The method of Claim 8, further comprising:
updating the moving average provided the signals are within a moving average threshold, wherein the moving average threshold is larger than the void flags threshold.

10. The method of Claim 8, further comprising:
provided the reflected signals are within the void flags threshold, making the determination that a darkfield candidate image can be captured at the sensor.

11. The method of Claim 1, further comprising:
responsive to detecting an object interacting with the sensor, capturing an image comprising the object; and
correcting the image using the darkfield estimate.

12. The method of Claim 1, further comprising:
provided an object is interacting with the sensor, making the determination that a darkfield candidate image cannot be captured at the sensor.

13. The method of Claim 12, further comprising:
responsive to making the determination that a darkfield candidate image cannot be captured at the sensor, activating a timer; and
responsive to a predetermined period of the timer lapsing, repeating the determining whether an object is interacting with the sensor.

14. The method of Claim 12, further comprising:

responsive to making the determination that a darkfield candidate image cannot be captured at the sensor, comparing a signal received at the sensor to a sensor temperature correlation scheme; and

modifying signal thresholds according to the sensor temperature correlation scheme during the determining whether an object is interacting with the sensor.

15. The method of Claim 1, further comprising:
provided an object is not interacting with the sensor;
determining a temperature of the sensor;
associating the temperature with a corresponding pixel value; and
storing the temperature and pixel value pair.

16. The method of Claim 1, wherein determining whether an object is interacting with the sensor comprises:

measuring a temperature of the sensor;
receiving a pixel value for a pixel of the sensor;
comparing the pixel value to an expected pixel value based on the temperature of the sensor; and

determining whether an object is interacting with the sensor based on the comparing the pixel value to an expected pixel value based on the temperature of the sensor.

17. The method of Claim 16, wherein the pixel value is received for a plurality of pixels/.

18. An electronic device comprising:

a fingerprint sensor;

a memory; and

a processor configured to:

determine whether an object is interacting with the fingerprint sensor;

provided an object is not interacting with the sensor, make a determination that a darkfield candidate image can be captured at the sensor;

determine whether to capture a darkfield candidate image at the sensor based at least in part on the determination that a darkfield candidate image can be captured at the sensor;

responsive to making a determination to capture the darkfield candidate image, capture the darkfield candidate image at the sensor, wherein the darkfield candidate image is an image absent an object interacting with the sensor; and

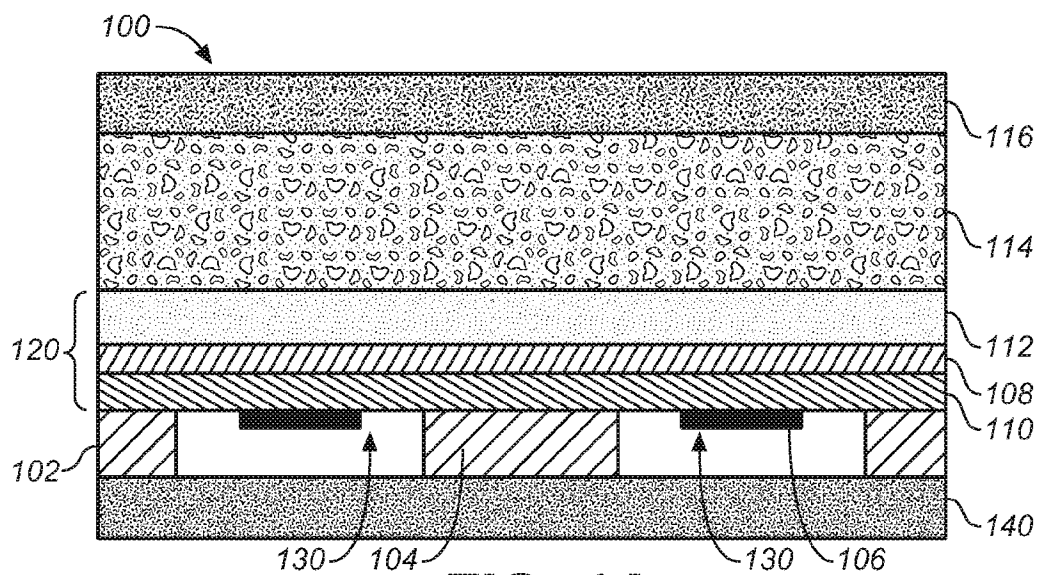
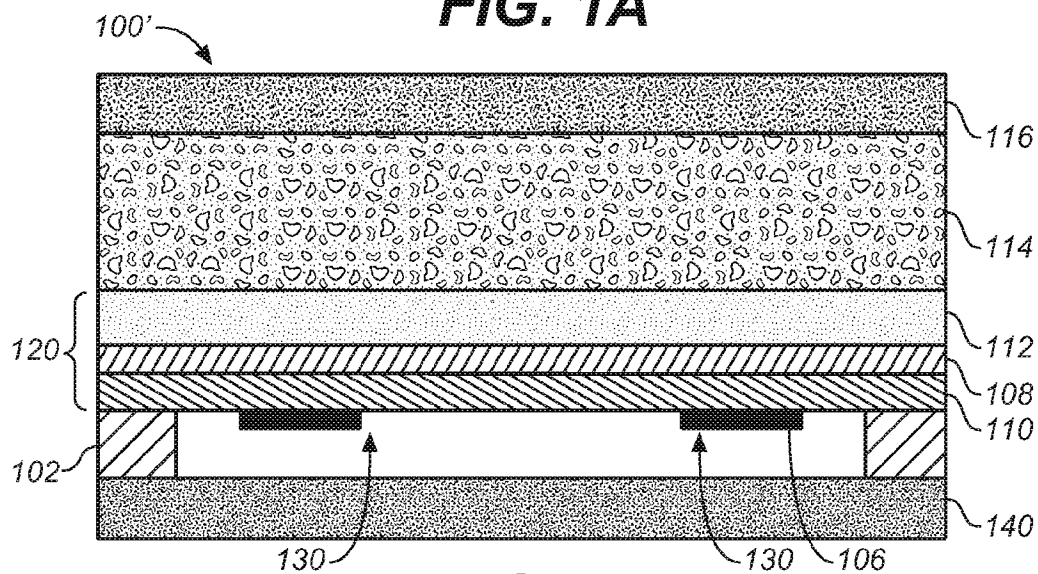
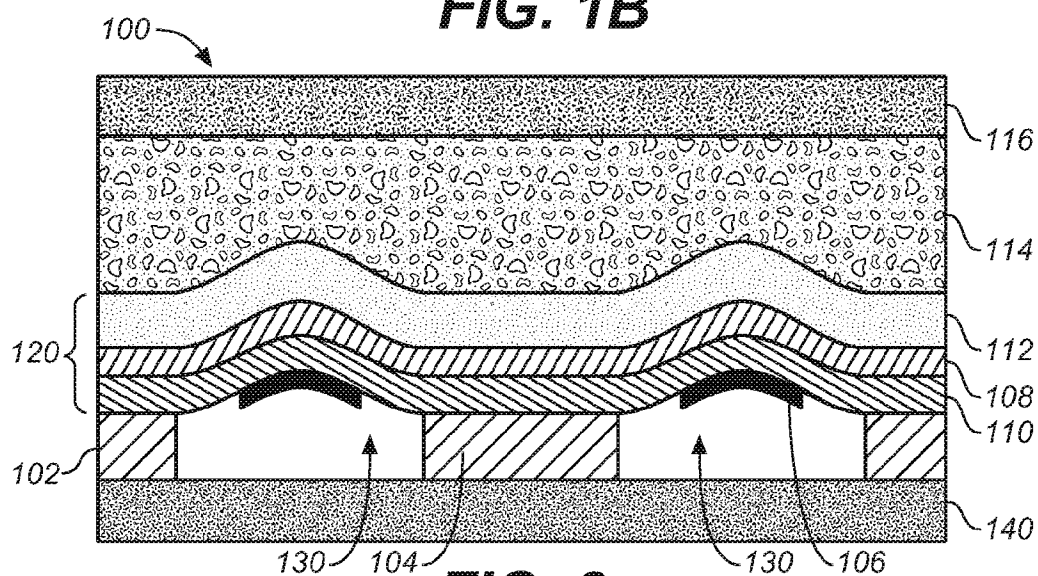
update a darkfield estimate with the darkfield candidate image.

19. The electronic device of Claim 18, wherein the processor is further configured to: merge the darkfield candidate image with the darkfield estimate.
20. The electronic device of Claim 18, wherein the fingerprint sensor is an ultrasonic fingerprint sensor, wherein the processor is further configured to:
transmit signals at ultrasonic transducers of the ultrasonic sensor;
receive reflected signals at ultrasonic transducers of the ultrasonic sensor; and
provided the signals are not indicative of an object interacting with the ultrasonic sensor, determine that an object is not interacting with the ultrasonic sensor
21. The electronic device of Claim 18, wherein the processor is further configured to:
responsive to detecting an object interacting with the fingerprint sensor, capture an image comprising the object; and
correct the image using the darkfield estimate.
22. The electronic device of Claim 21, wherein the processor is further configured to:

forward the image to a matcher for authentication.
23. A non-transitory computer readable storage medium having computer readable program code stored thereon for causing a computer system to perform a method for darkfield tracking at a sensor, the method comprising:
determining whether an object is interacting with the sensor;
provided an object is not interacting with the sensor, making a determination that a darkfield candidate image can be captured at the sensor;
determining whether to capture a darkfield candidate image at the sensor based at least in part on the determination that a darkfield candidate image can be captured at the sensor;
responsive to making a determination to capture the darkfield candidate image, capturing the darkfield candidate image at the sensor, wherein the darkfield candidate image is an image absent an object interacting with the sensor;
updating a darkfield estimate with the darkfield candidate image;
responsive to detecting an object interacting with the sensor, capturing an image comprising the object; and
correcting the image using the darkfield estimate.

24. The non-transitory computer readable storage medium of Claim 23, wherein the updating the darkfield estimate with the darkfield candidate image comprises:
- merging the darkfield candidate image with the darkfield estimate.
25. The non-transitory computer readable storage medium of Claim 23, wherein the sensor is an ultrasonic sensor, wherein the determining whether an object is interacting with the sensor comprises:
- transmitting signals at ultrasonic transducers of the ultrasonic sensor;
 - receiving reflected signals at ultrasonic transducers of the ultrasonic sensor; and
 - provided the signals are not indicative of an object interacting with the ultrasonic sensor, determining that an object is not interacting with the ultrasonic sensor.

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**FIG. 1A****FIG. 1B****FIG. 2**

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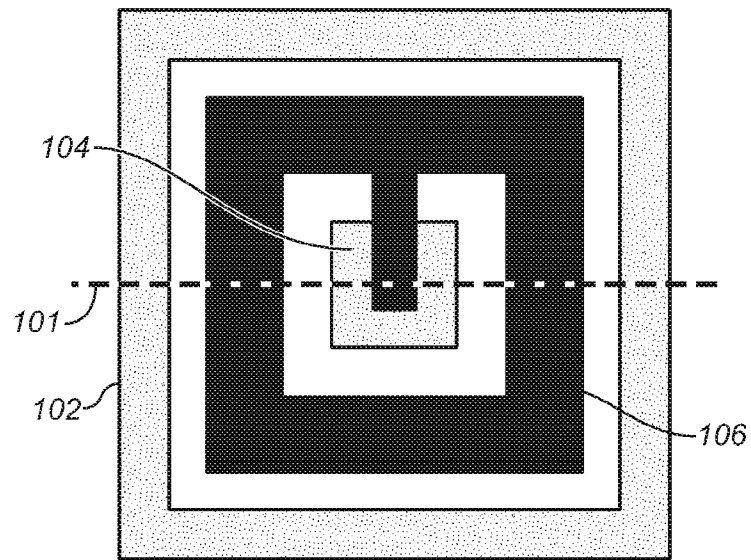


FIG. 3

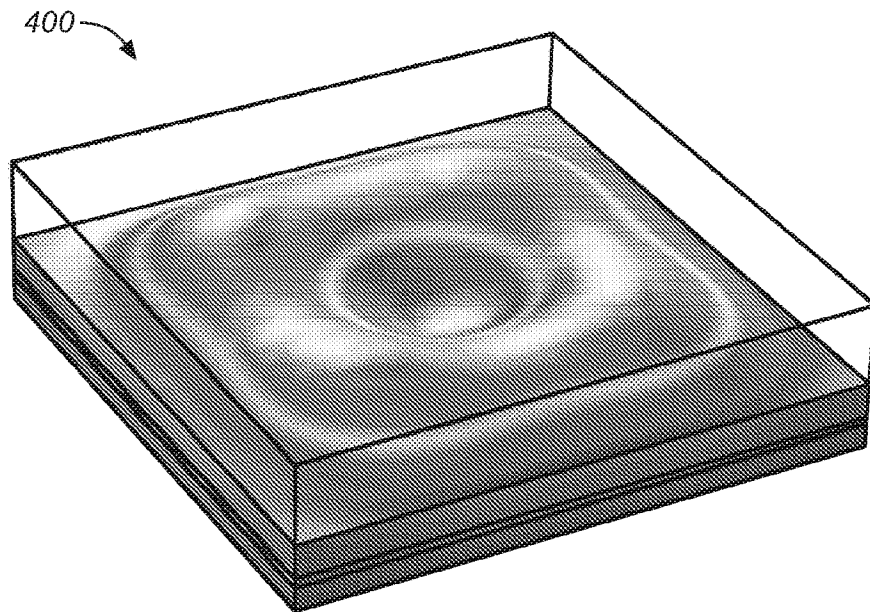
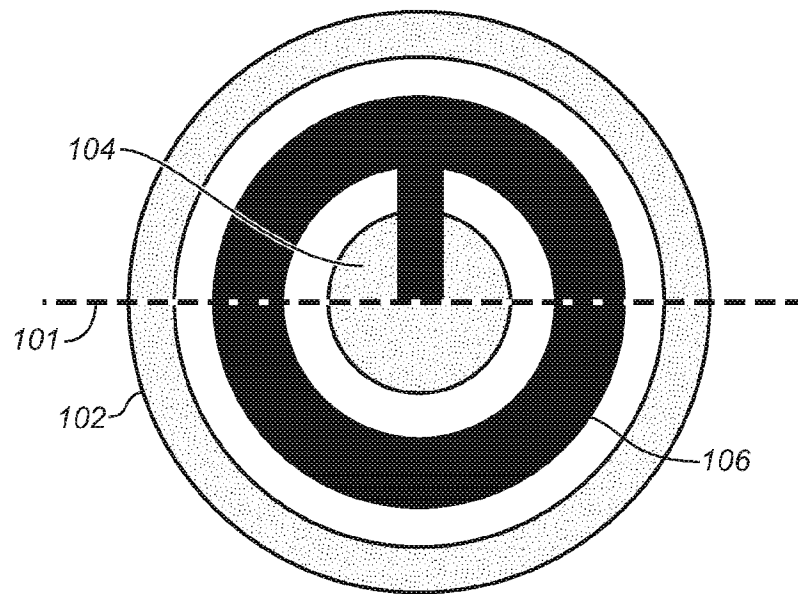
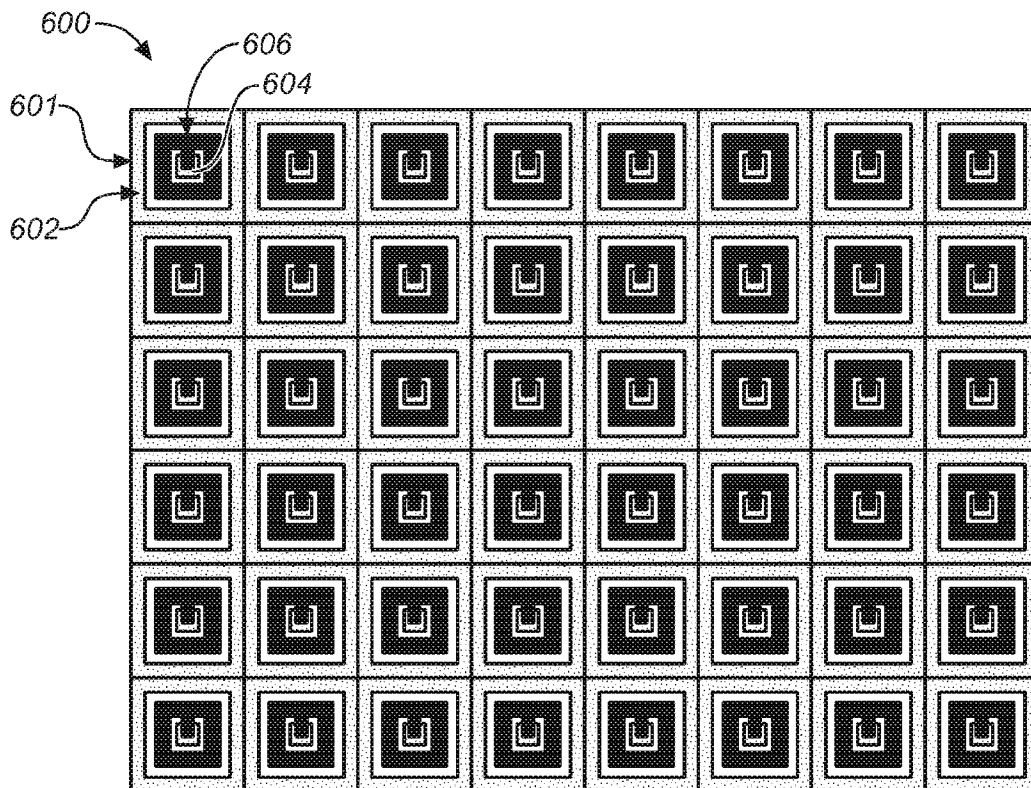
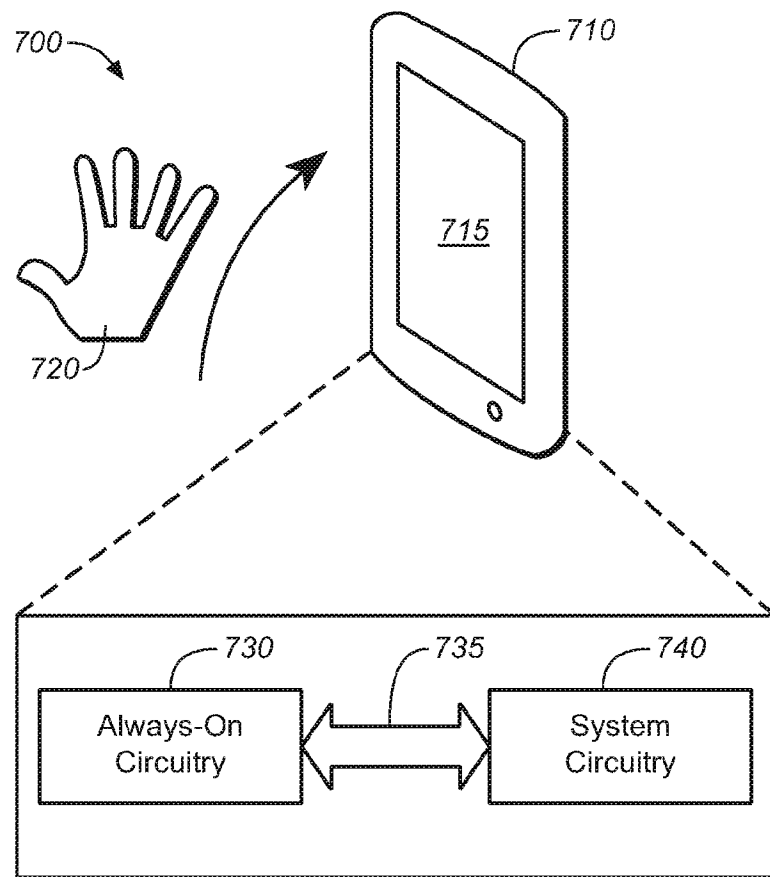
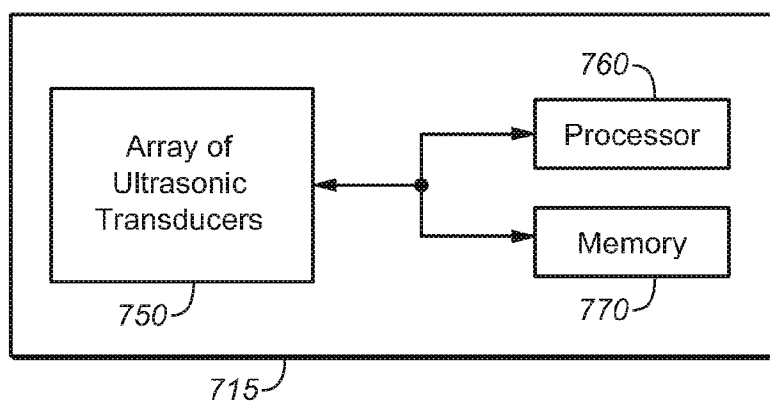


FIG. 4

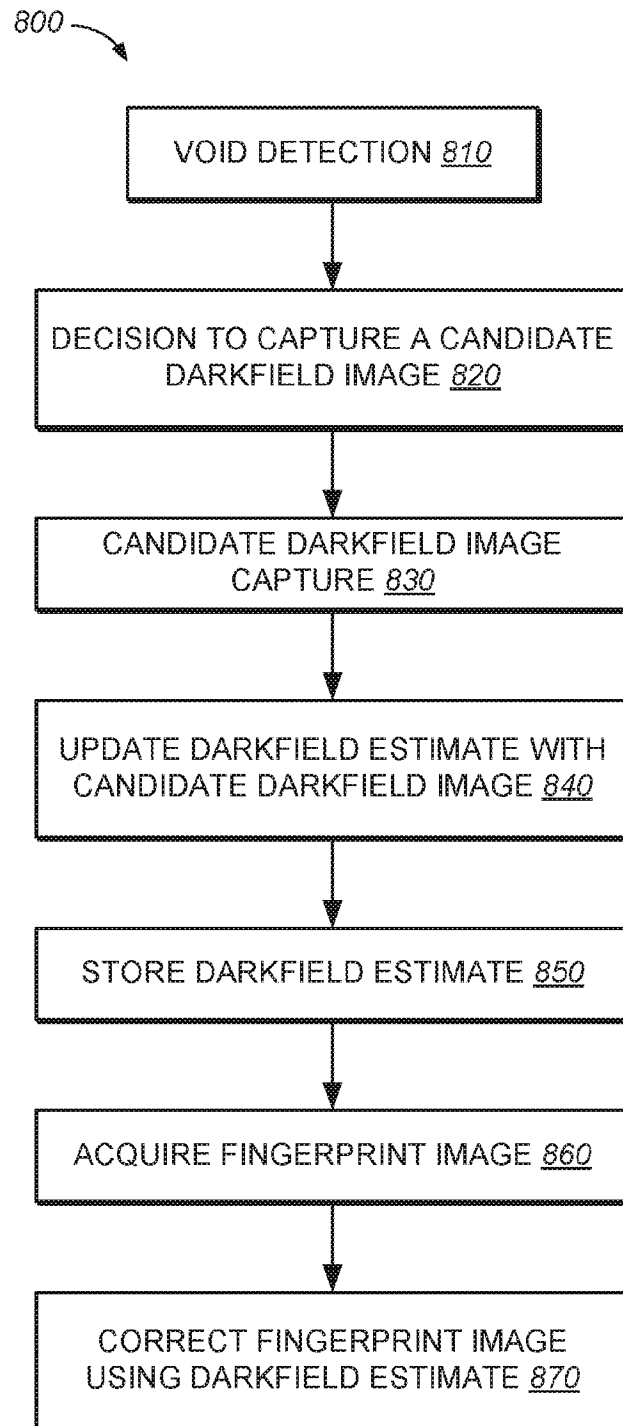
3 / 14

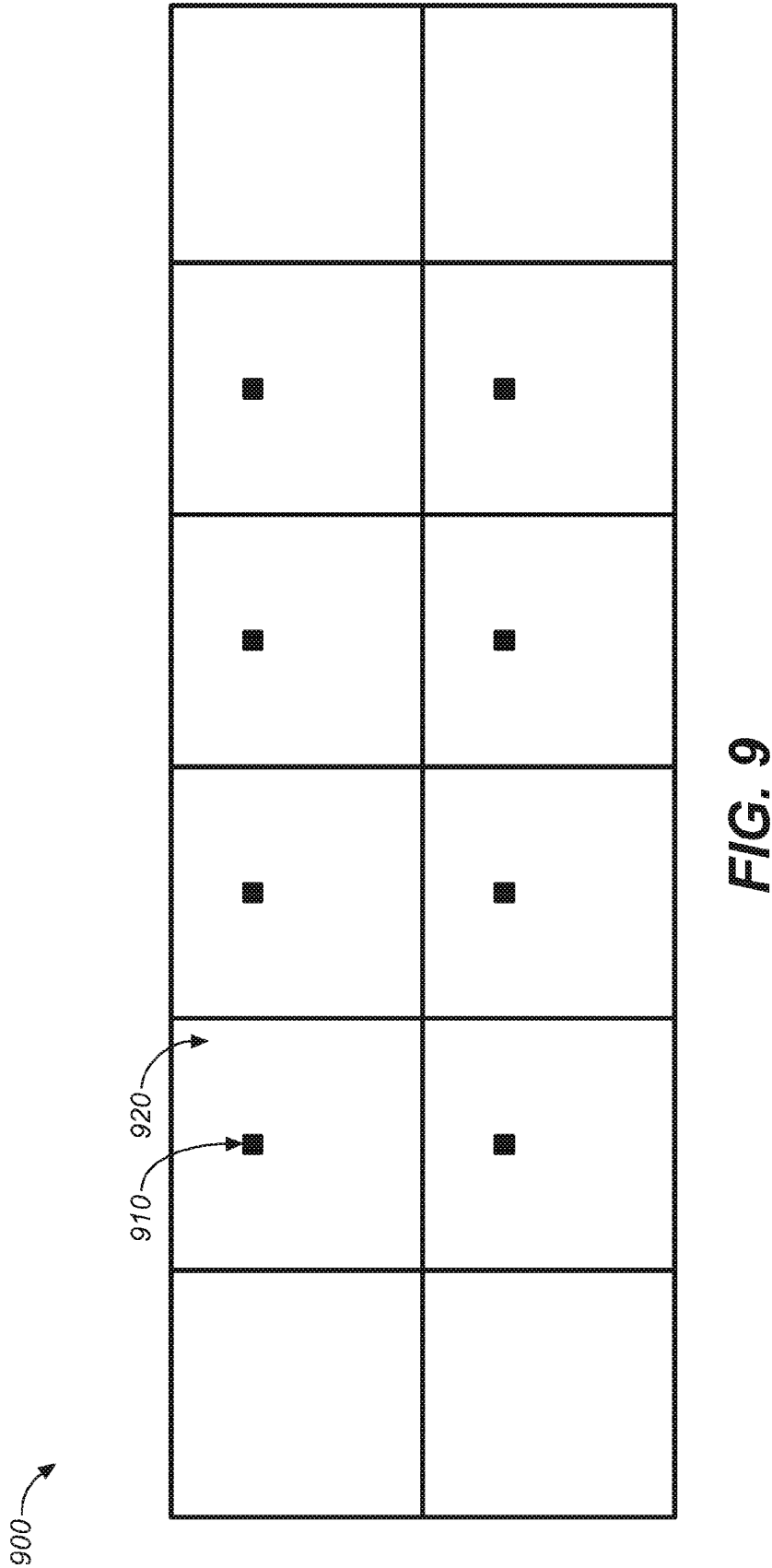
**FIG. 5****FIG. 6**

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**FIG. 7A****FIG. 7B**

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**FIG. 8**



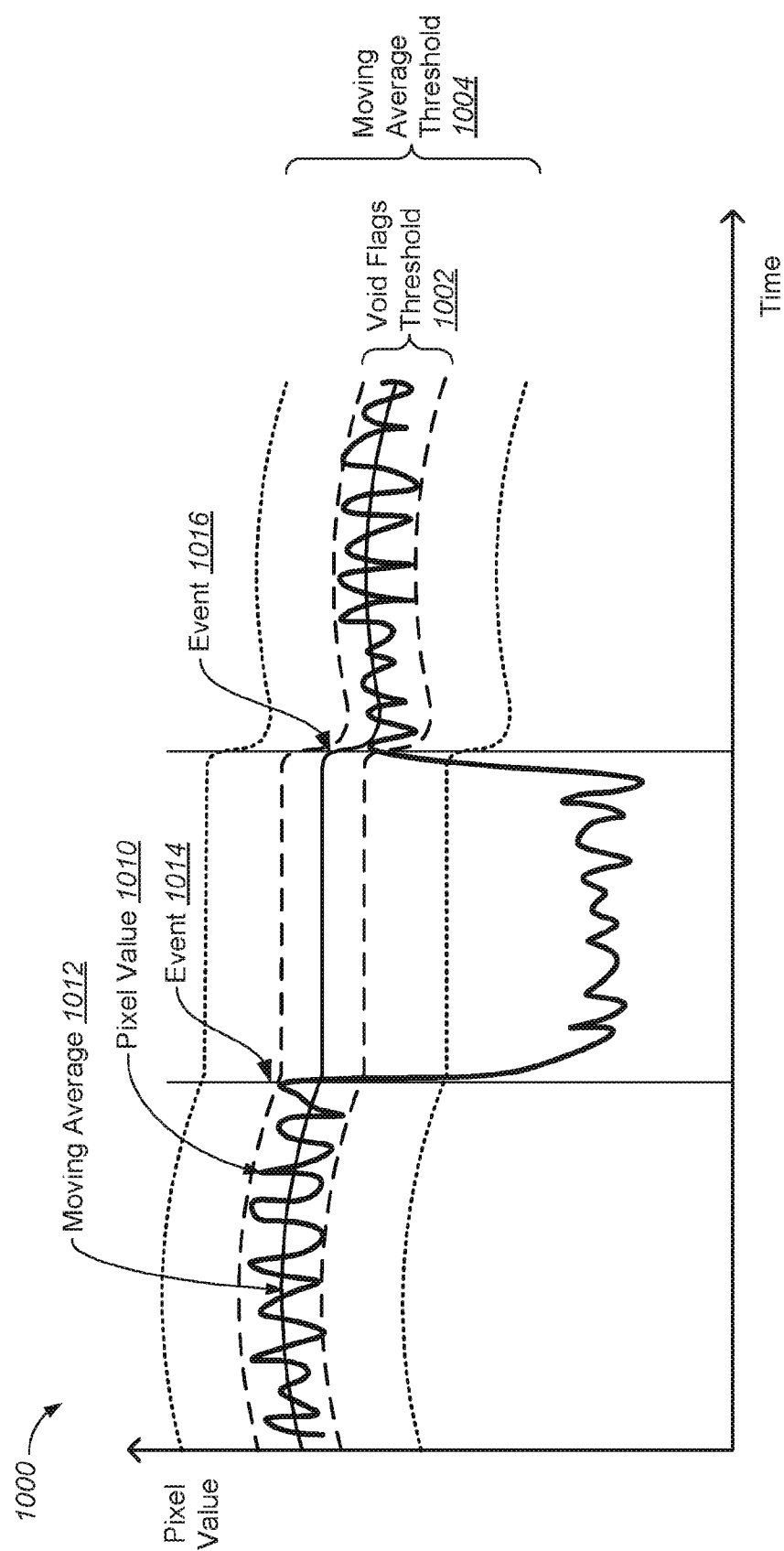


FIG. 10A

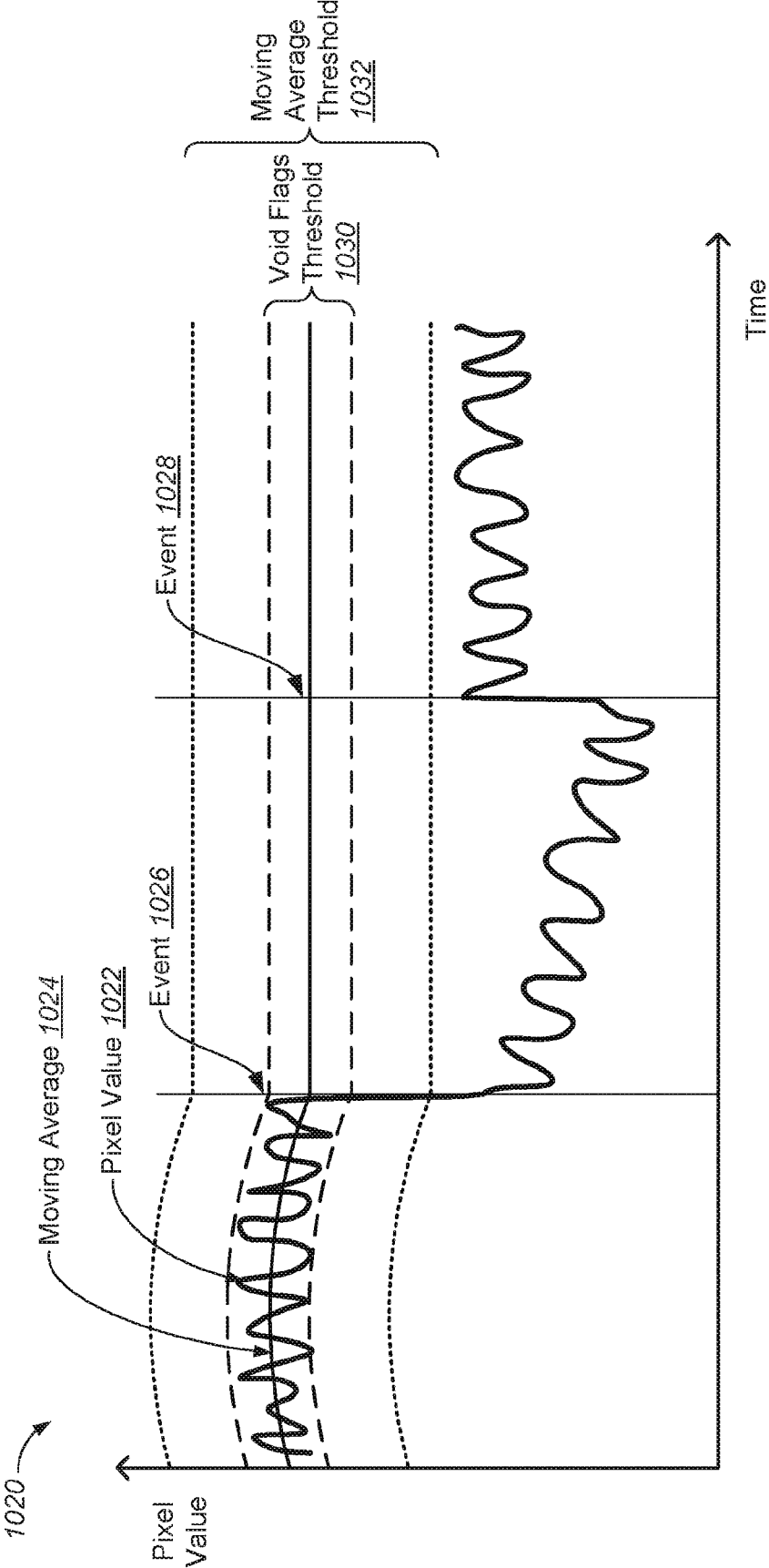


FIG. 10B

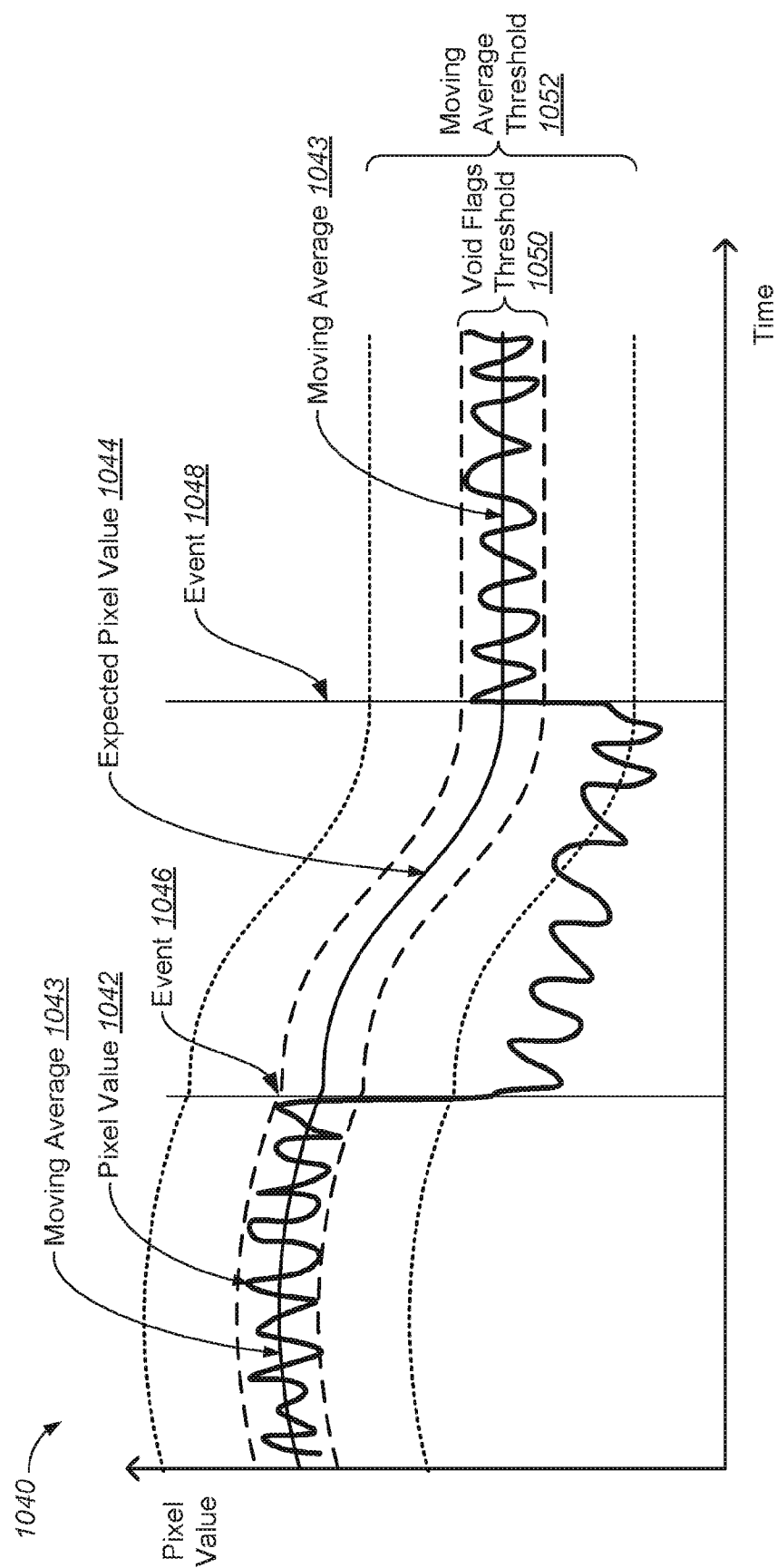


FIG. 10C

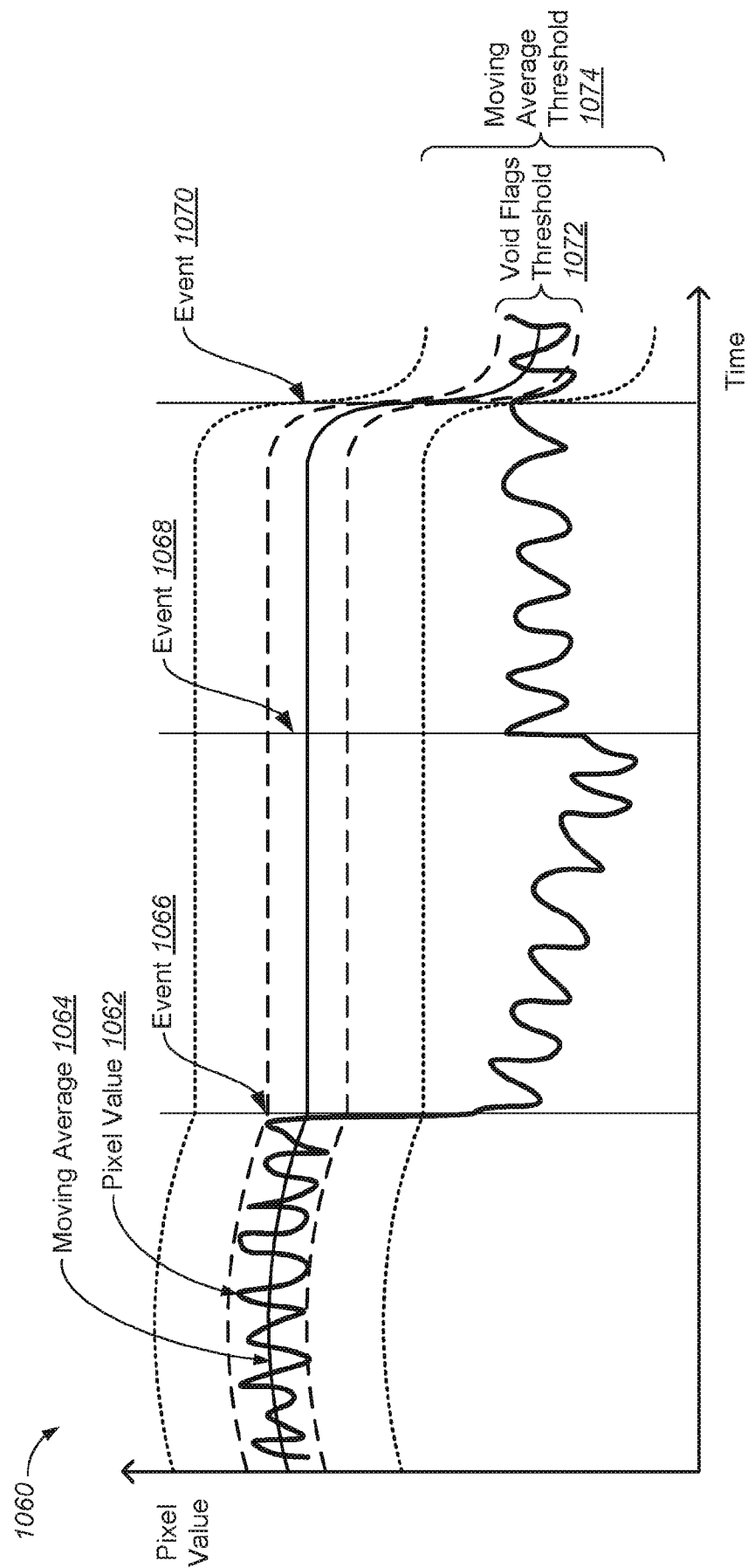


FIG. 10D

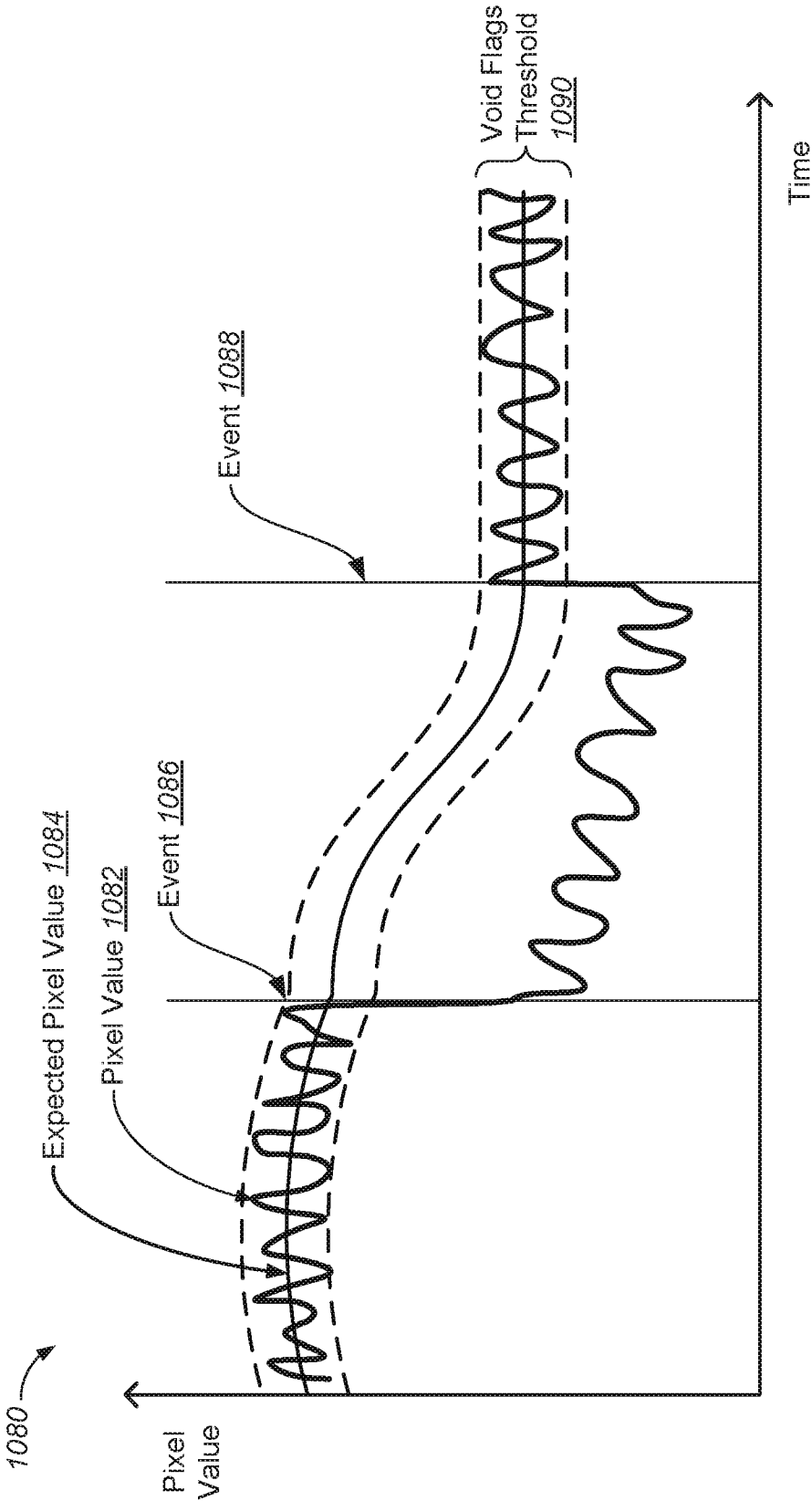
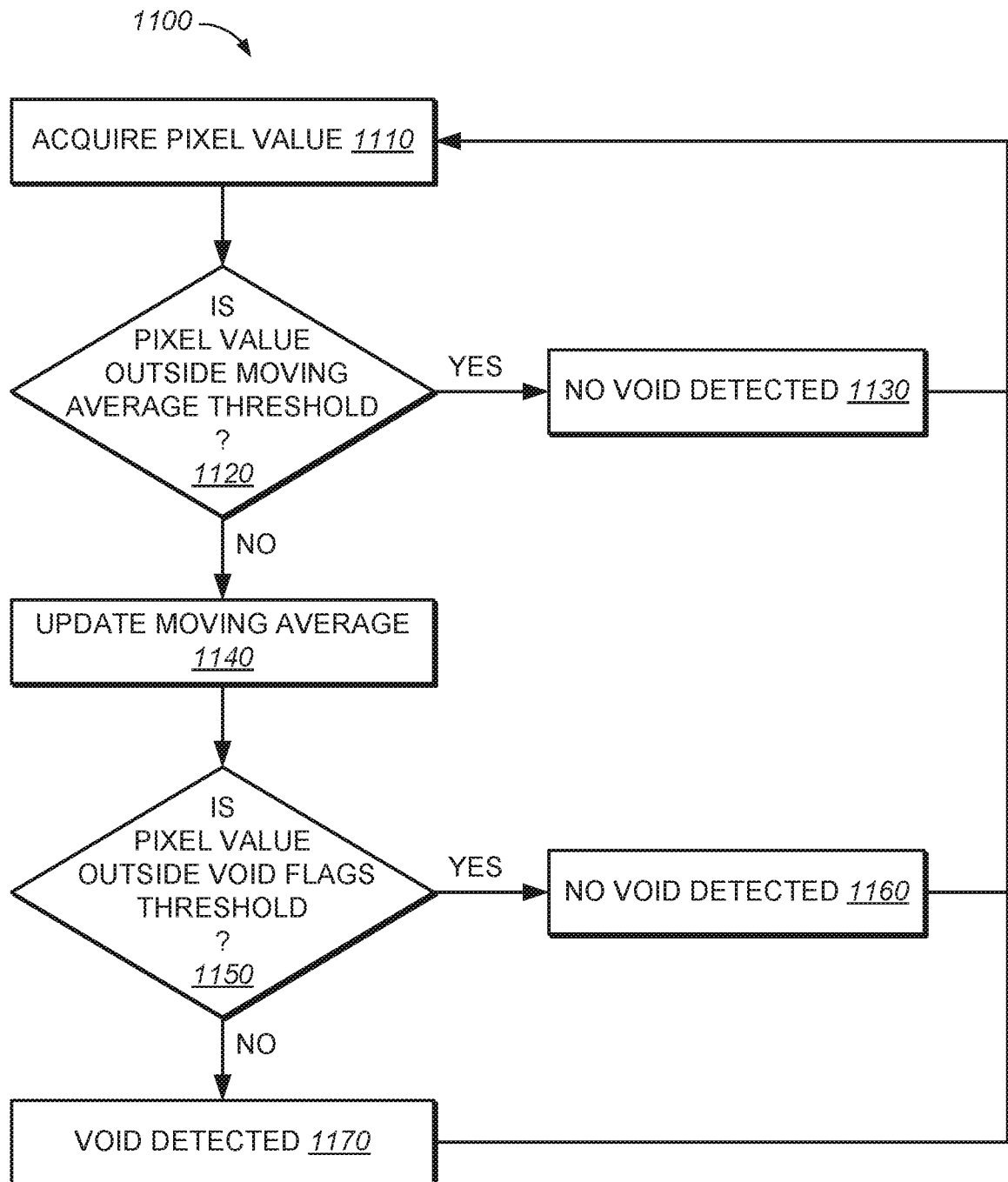
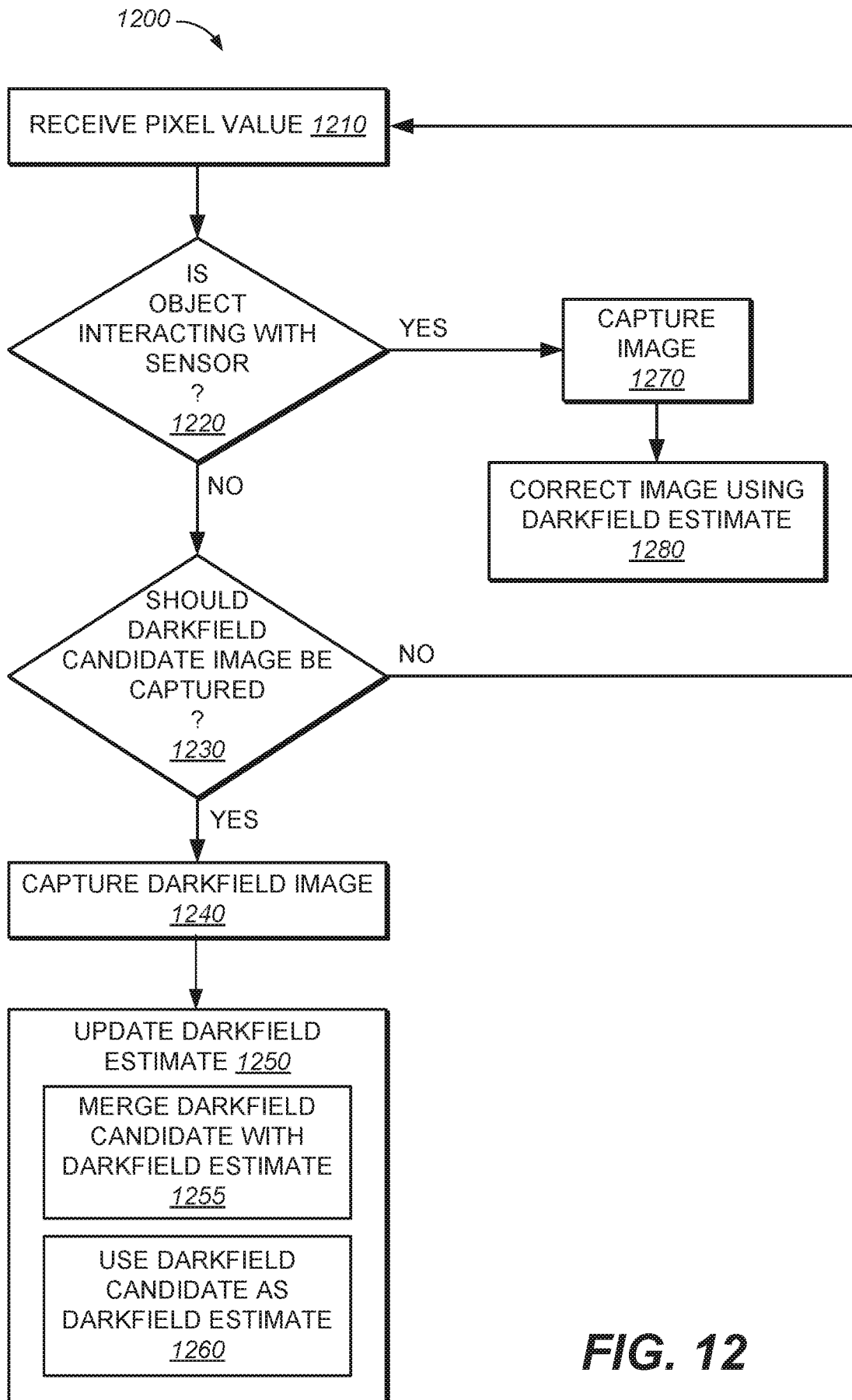
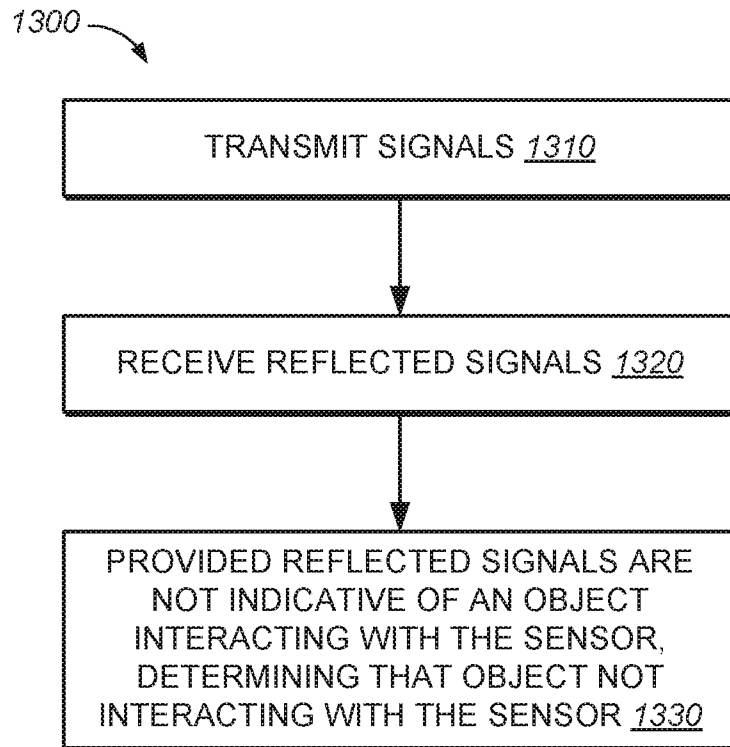
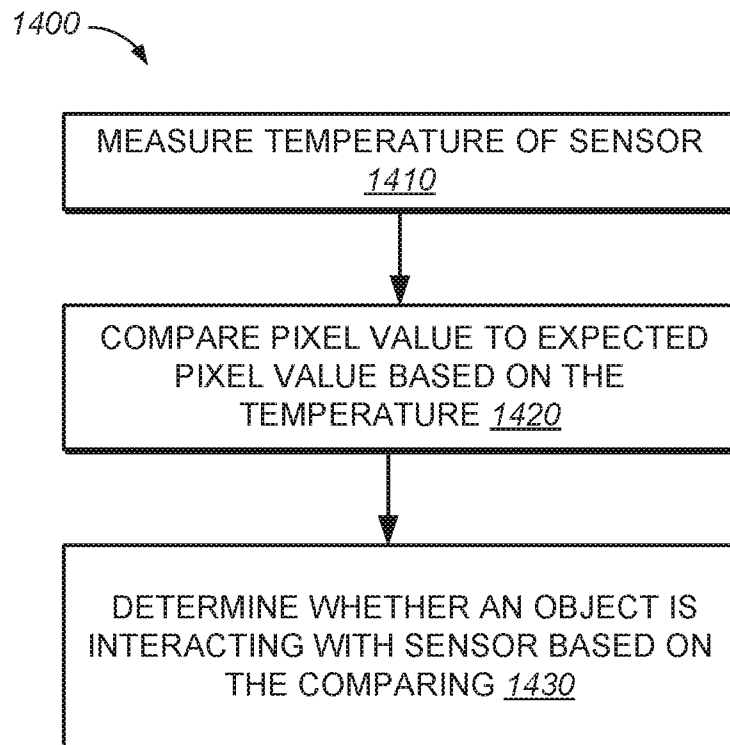


FIG. 10E

**FIG. 11**

**FIG. 12**

**FIG. 13****FIG. 14**

INTERNATIONAL SEARCH REPORT

International application No
PCT/US2018/063431

A. CLASSIFICATION OF SUBJECT MATTER
INV. G06K9/00
ADD.

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)
G06K

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practicable, search terms used)

EPO-Internal, WPI Data

C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X	US 2017/231534 A1 (AGASSY MEIR [IL] ET AL) 17 August 2017 (2017-08-17) abstract figures 1B-2B paragraph [0006] - paragraph [0008] paragraph [0013] - paragraph [0015] paragraph [0028] - paragraph [0040] paragraph [0054] - paragraph [0092] ----- -/-	1-25



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See patent family annex.

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Date of the actual completion of the international search

28 January 2019

Date of mailing of the international search report

05/02/2019

Name and mailing address of the ISA/

European Patent Office, P.B. 5818 Patentlaan 2
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Fax: (+31-70) 340-3016

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Karwe, Markus

INTERNATIONAL SEARCH REPORT

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PCT/US2018/063431

C(Continuation). DOCUMENTS CONSIDERED TO BE RELEVANT		
Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
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A	Anonymous: "Moving Average Filters", Waybackmachine 9 August 2017 (2017-08-09), pages 1-8, XP055547422, Retrieved from the Internet: URL:https://web.archive.org/web/20170809081353/https://www.analog.com/media/en/technical-documentation/dsp-book/dsp_book_Ch15.pdf [retrieved on 2019-01-24] the whole document	1-25
A	Texas Instrument: "TMS320C5515 Fingerprint Development Kit (FDK) Hardware Guide User's Guide" In: Anonymous: "TMS320C5515 Fingerprint Development Kit (FDK) Hardware Guide User's Guide", 1 April 2010 (2010-04-01), XP055547651, page 6	1-25
A	WO 2017/003848 A1 (SYNAPTICS INC [US]) 5 January 2017 (2017-01-05) abstract paragraph [0002] - paragraph [0016] paragraph [0027] - paragraph [0038] paragraph [0042] - paragraph [0043]	1-25
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INTERNATIONAL SEARCH REPORT

International application No

PCT/US2018/063431

C(Continuation). DOCUMENTS CONSIDERED TO BE RELEVANT		
Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
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INTERNATIONAL SEARCH REPORT

Information on patent family members

International application No

PCT/US2018/063431

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		WO 2016051087 A1	07-04-2016
